

### Quad, 16-Bit, 4 MSPS, Simultaneous Sampling, $\mu$ Module Data Acquisition Solution

#### FEATURES

- ▶ Easy to use  $\mu$ Module® data acquisition system
  - ▶ 11 $\times$  footprint reduction vs. discrete solution
  - ▶ Integrated critical passive components
  - ▶ 5 V single-supply operation
- ▶ Guaranteed 16-bit no missing codes
- ▶ On-chip oversampling function
- ▶ 2-bit resolution boost
- ▶ Out of range indicator ( $\overline{\text{ALERT}}$ )
- ▶ INL:  $\pm 0.6$  LSB typical,  $\pm 2$  LSB maximum
- ▶ SNR (typical)
  - ▶ 91.0 dB at gain = 1.0,  $f_{\text{IN}} = 1$  kHz
  - ▶ 98.3 dB with OSR =  $\times 8$  at gain = 1.0,  $f_{\text{IN}} = 1$  kHz
- ▶ Channel-to-channel phase matching:  $0.005^\circ$  typical at  $f_{\text{IN}} = 20$  kHz
- ▶ Integrated high precision reference, 3 ppm/ $^\circ\text{C}$  typical drift
- ▶ Gain error: 0.005% typical
- ▶ Gain drift: 0.8 ppm/ $^\circ\text{C}$  typical
- ▶ Integrated internal buffer with VCM generation
- ▶ Integrated fully differential ADC driver with signal scaling
  - ▶ Wide input common-mode voltage range
  - ▶ High common-mode rejection
- ▶ Single-ended to differential conversion
- ▶ Pin selectable input range with overrange
  - ▶ Input ranges:  $\pm 2$  V,  $\pm 3.3$  V,  $\pm 5.5$  V,  $\pm 11$  V
  - ▶ Gain/attenuation: G = 0.3, 0.6, 1.0, and 1.6
- ▶ High-speed serial interface
- ▶ 8 mm x 8 mm, 0.8 mm pitch, 81-ball CSP\_BGA package

#### APPLICATIONS

- ▶ Lab grade battery test system
- ▶ Motor control current sense
- ▶ Motor control position feedback
- ▶ Sonar
- ▶ Power quality monitoring
- ▶ Data acquisition system
- ▶ Erbium-doped fiber amplifier (EDFA) applications
- ▶ I and Q demodulation

#### GENERAL DESCRIPTION

The ADAQ4380-4 is a quad-channel precision data acquisition (DAQ) signal chain  $\mu$ Module solution that reduces the development cycle of a precision measurement system by transferring the signal chain design challenges of component selection, optimization, and layout from the designer to the device.

Using system-in-package (SIP) technology, the ADAQ4380-4 reduces end system component count by combining multiple common signal processing and conditioning blocks into a single device. These blocks include a quad-channel, high resolution 16-bit, 4 MSPS simultaneous sampling SAR ADC, low noise, fully differential ADC driver amplifier, a 3.3 V precision voltage reference, low noise buffer amplifiers, and low-dropout linear regulator.

The ADAQ4380-4 has on-chip oversampling blocks to improve dynamic range and reduce noise at lower bandwidths. The oversampling can boost up to two bits of added resolution. It provides the flexibility of a configurable ADC driver feedback loop to allow four gain and attenuation adjustments, and accept both fully differential or single-ended to differential input configuration.

Using Analog Devices, Inc., iPassives® technology, the ADAQ4380-4 incorporates critical passive components with superior matching and drift characteristics to minimize temperature dependent error sources and to offer optimized signal chain performance. Housed in a small 8 mm  $\times$  8 mm  $\times$  0.8 mm pitch, 81-ball CSP\_BGA package, the ADAQ4380-4 enables compact design without sacrificing performance and simplifies end system bill of materials management. The ADAQ4380-4's optimum performance is guaranteed with a single 5 V supply operation, all the required bypass and decoupling capacitors are included inside the package. The level of ADAQ4380-4 system integration solves many design challenges, which enables a compact and simple solution for a multichannel application.

The conversion result can clock out simultaneously through 4-wire mode for faster throughput or through 1-wire serial mode when slower throughput is allowed. The ADAQ4380-4 is compatible with 1.8 V, 2.5 V, and 3.3 V interfaces using the separate logic supply. The ADAQ4380-4 is specified to operate over a temperature range of  $-40^\circ\text{C}$  to  $+105^\circ\text{C}$ .

**Table 1.  $\mu$ Module Data Acquisition Solutions**

| Type   | 500 kSPS | 1 MSPS to 2 MSPS                   | 4 MSPS     |
|--------|----------|------------------------------------|------------|
| 14-bit |          |                                    | ADAQ4381-4 |
| 16-bit | ADAQ7988 | ADAQ4370-4<br>ADAQ7980<br>ADAQ4001 | ADAQ4380-4 |
| 18-bit |          | ADAQ4003                           |            |

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## REVISION HISTORY

**8/2024—Rev. A to Rev. B**

|   |    |
|---|----|
| Change to Features Section.....   | 1  |
| Changes to General Description Section and Table 1.....   | 1  |
| Changes to Figure 1.....  | 3  |
| Changes to OUT_LDO Voltage Parameter, Output High Voltage ( $V_{OH}$ ) Parameter, and $V_{LOGIC}$ Parameter, Table 2.....                           | 4  |
| Changes to Timing Specifications Section, $t_{CSH}$ Parameter, $t_{QUIET}$ Parameter, $t_{SDOEN}$ Parameter, and $t_{SDOS}$ Parameter, Table 3..... | 8  |
| Changes to Table 4.....   | 11 |
| Changes to Figure 46.....   | 22 |
| Changes to Internal Reference Section.....  | 29 |
| Added Figure 60; Renumbered Sequentially.....   | 29 |
| Change to Oversampling Section.....   | 31 |

**5/2024—Rev. 0 to Rev. A**

|   |   |
|---|---|
| Change to General Description Section.....                                  | 1 |
| Changes to $V_{REFSENSE}$ Parameter and $V_{LOGIC}$ Parameter, Table 2..... | 4 |
| Changes to Timing Specifications Section.....                               | 8 |
| Changes to $t_{SDOEN}$ Parameter and $t_{SDOS}$ Parameter, Table 3.....     | 8 |

**5/2024—Revision 0: Initial Version**

## TYPICAL APPLICATION DIAGRAM

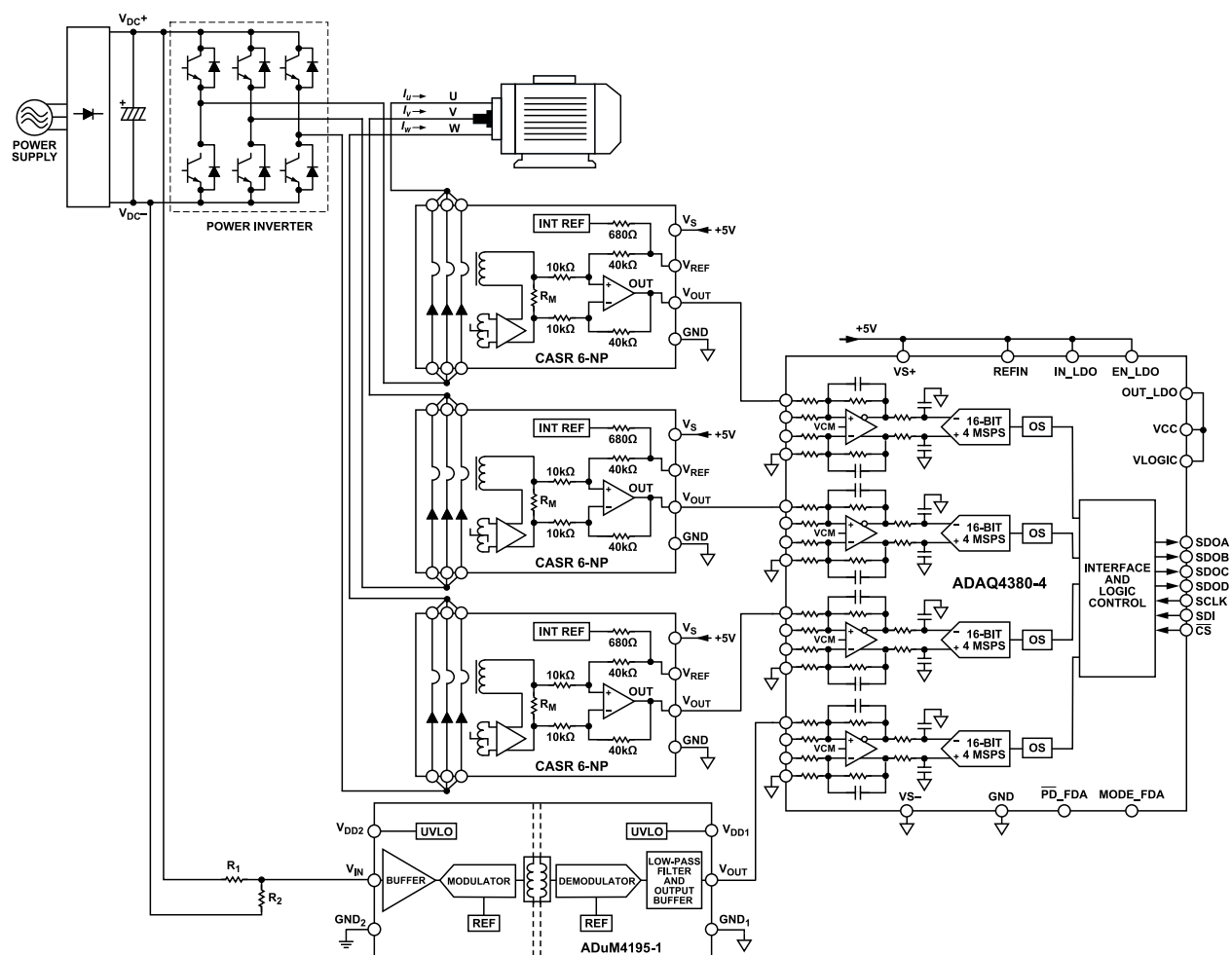


Figure 1. Precision Current and Voltage Sensing for Servo Motors Control

## SPECIFICATIONS

$V_{S+} = \text{REFIN} = \text{IN\_LDO} = \text{EN\_LDO} = 5 \text{ V} \pm 5\%$ ,  $V_{CC} = V_{\text{LOGIC}} = 3.45 \text{ V}$  (OUT\_LDO),  $V_{S-} = 0 \text{ V}$ , reference voltage ( $V_{\text{REF}}$ ) = 3.3 V internal,  $f_{\text{SAMPLE}} = 4 \text{ MSPS}$ , fully differential input configuration, full power mode,  $T_A = 25^\circ\text{C}$ , no oversampling, unless otherwise noted.

Table 2. Electrical Specifications

| Parameter   | Test Conditions/Comments   | Min     | Typ        | Max     | Unit                         |
|---|--|---------|------------|---------|------------------------------|
| RESOLUTION  |  | 16      |            |         | Bits                         |
| ANALOG INPUT CHARACTERISTICS                        |  |         |            |         |                              |
| Differential Input Voltage Range, $V_{\text{IN}}^1$ | Gain = 0.3, $V_{\text{IN}} = 22 \text{ V p-p}$                       | -11     |            | +11     | V                            |
|   | Gain = 0.6, $V_{\text{IN}} = 11 \text{ V p-p}$                       | -5.5    |            | +5.5    | V                            |
|   | Gain = 1.0, $V_{\text{IN}} = 6.6 \text{ V p-p}$                      | -3.3    |            | +3.3    | V                            |
|   | Gain = 1.6, $V_{\text{IN}} = 4.125 \text{ V p-p}$                    | -2.0625 |            | +2.0625 | V                            |
| Input Resistance, $R_{\text{IN}}$                   | Fully differential input configuration                               |         |            |         |                              |
|   | Gain = 0.3, 0.6  |         | 5.40       |         | k $\Omega$                   |
|   | Gain = 1.0   |         | 3.24       |         | k $\Omega$                   |
|   | Gain = 1.6   |         | 2.026      |         | k $\Omega$                   |
|   | Single-ended input configuration                                     |         |            |         |                              |
|   | Gain = 0.3   |         | 3.05       |         | k $\Omega$                   |
|   | Gain = 0.6   |         | 3.32       |         | k $\Omega$                   |
|   | Gain = 1.0   |         | 2.16       |         | k $\Omega$                   |
|   | Gain = 1.6   |         | 1.46       |         | k $\Omega$                   |
|   | Input Capacitance  |         | 2          |         | pF                           |
| THROUGHPUT  |  |         |            |         |                              |
| Complete Cycle                                      |  | 250     |            |         | ns                           |
| Conversion Time                                     |  |         |            | 190     | ns                           |
| Acquisition Phase                                   |  | 110     |            |         | ns                           |
| Conversion Rate                                     |  |         |            | 4       | MSPS                         |
| SAMPLING DYNAMICS                                   |  |         |            |         |                              |
| Aperture Delay                                      |  |         | 2          |         | ns                           |
| Aperture Delay Match                                |  |         | 46.8       | 145     | ps                           |
| Aperture Jitter                                     |  |         | 20         |         | ps                           |
| OVERALL SYSTEM DC ACCURACY                          |  |         |            |         |                              |
| No Missing Codes                                    |  | 16      |            |         | Bits                         |
| Differential Nonlinearity Error (DNL)               | All gains, $V_{S-} = 0 \text{ V}$                                    | -0.99   | $\pm 0.5$  | +1      | LSB                          |
| Integral Nonlinearity Error (INL) <sup>2</sup>      | All gains, $V_{S-} = 0 \text{ V}$                                    | -2      | $\pm 0.6$  | +2      | LSB                          |
| Gain Error  | Gain = 0.3   | -0.08   | $\pm 0.01$ | +0.08   | %FS                          |
|   | Gain = 0.6, 1.0, 1.6   | -0.05   | $\pm 0.01$ | +0.05   | %FS                          |
| Gain Error Drift                                    | All gains  |         | 0.8        |         | ppm/ $^\circ\text{C}$        |
| Offset Error, Referred to Output (RTO)              | Gain = 0.3   | -0.65   | $\pm 0.03$ | +0.65   | mV                           |
|   | Gain = 0.6   | -0.6    | $\pm 0.03$ | +0.6    | mV                           |
|   | Gain = 1.0   | -0.75   | $\pm 0.03$ | +0.75   | mV                           |
|   | Gain = 1.6   | -0.9    | $\pm 0.03$ | +0.9    | mV                           |
| Offset Error Drift                                  | All gains  | -2      | $\pm 0.5$  | +2      | $\mu\text{V}/^\circ\text{C}$ |
| Common-Mode Rejection Ratio (CMRR)                  | $\Delta V_{\text{ICM}}/\Delta V_{\text{OSDIFF}}$                     |         | 80         |         | dB                           |
| Power-Supply Rejection Ratio                        | $V_{S+}$ , REFIN, IN_LDO = 4.75 V to 5.25 V, $V_{S-} = \text{GND}$   |         | 95         |         | dB                           |
| OVERALL SYSTEM AC ACCURACY <sup>3</sup>             |  |         |            |         |                              |
| Dynamic Range                                       | Fully differential and single-ended input configuration              |         |            |         |                              |
|   | $V_{\text{IN}} = -60 \text{ dBFS}$ , $f_{\text{IN}} = 1 \text{ kHz}$ |         |            |         |                              |
|   | Gain = 0.3   |         | 92.6       |         | dB                           |
|   | Gain = 0.6   |         | 92.3       |         | dB                           |
|   | Gain = 1.0   |         | 92.0       |         | dB                           |
|   | Gain = 1.6   |         | 91.6       |         | dB                           |

## SPECIFICATIONS

Table 2. Electrical Specifications (Continued)

| Parameter                                 | Test Conditions/Comments                                 | Min   | Typ   | Max   | Unit          |
|---|--|-------|-------|-------|---------------|
| Total RMS Noise, Referred to Output (RTO) | $V_{IN} = -60$ dBFS, $f_{IN} = 1$ kHz                    |       |       |       |               |
|   | Gain = 0.3   |       | 54.7  |       | $\mu V_{RMS}$ |
|   | Gain = 0.6   |       | 56.6  |       | $\mu V_{RMS}$ |
|   | Gain = 1.0   |       | 58.6  |       | $\mu V_{RMS}$ |
|   | Gain = 1.6   |       | 61.4  |       | $\mu V_{RMS}$ |
| Signal-to-Noise Ratio                     | $V_{IN} = -0.5$ dBFS, $f_{IN} = 1$ kHz                   |       |       |       |               |
|   | Gain = 0.3   | 88.6  | 91.6  |       | dB            |
|   | Gain = 0.6   | 88.3  | 91.3  |       | dB            |
|   | Gain = 1.0   | 88.0  | 91.0  |       | dB            |
|   | Gain = 1.6   | 87.6  | 90.6  |       | dB            |
|   | Gain = 1.0, rolling average OSR = 8 $\times$ , RES = 1   |       | 98.3  |       | dB            |
|   | Gain = 1.0, low-power mode                               |       | 90.2  |       | dB            |
|   | Gain = 1.0, $f_{IN} = 100$ kHz, full power mode          |       | 90.3  |       | dB            |
|   | Gain = 1.0, $f_{IN} = 200$ kHz, full power mode          |       | 88.9  |       | dB            |
| Signal-to-Noise + Distortion (SINAD)      | $V_{IN} = -0.5$ dBFS, $f_{IN} = 1$ kHz                   |       |       |       |               |
|   | Gain = 0.3   | 88.5  | 91.5  |       | dB            |
|   | Gain = 0.6   | 88.2  | 91.2  |       | dB            |
|   | Gain = 1.0   | 87.9  | 90.9  |       | dB            |
|   | Gain = 1.6   | 87.5  | 90.5  |       | dB            |
|   | Gain = 1.0, low-power mode                               |       | 90.1  |       | dB            |
|   | Gain = 1.0, $f_{IN} = 100$ kHz, full power mode          |       | 89.7  |       | dB            |
|   | Gain = 1.0, $f_{IN} = 200$ kHz, full power mode          |       | 88.4  |       | dB            |
| Total Harmonic Distortion                 | $V_{IN} = -0.5$ dBFS, $f_{IN} = 1$ kHz                   |       |       |       |               |
|   | All gains  |       | -109  |       | dB            |
| Spurious-Free Dynamic Range               | $V_{IN} = -0.5$ dBFS, $f_{IN} = 1$ kHz                   |       |       |       |               |
|   | All gains  |       | 110   |       | dB            |
| -3 dB Bandwidth                           | Gain = 0.3   |       | 12.5  |       | MHz           |
|   | Gain = 0.6, 1.0, 1.6                                     |       | 5.8   |       | MHz           |
| Channel-to-Channel Isolation              | All gains, $f_{IN} = 1$ kHz                              |       | -113  |       | dB            |
| Channel-to-Channel Phase Matching         | All gains, $f_{IN} = 20$ kHz                             |       | 0.005 |       | Degrees       |
| REFERENCE CHARACTERISTICS                 |  |       |       |       |               |
| $V_{REFIN}$                               | Internal-reference supply voltage                        | 4.5   | 5.0   | 5.5   | V             |
| $I_{REFIN}$                               | Internal-reference supply current                        |       | 350   | 600   | $\mu A$       |
| $V_{REFSENSE}$                            | Internal-reference output voltage sense                  |       | 3.3   |       | V             |
|   | -40°C to +105°C  | 3.285 |       | 3.315 | V             |
| $V_{REF}$ Temperature Coefficient         | $TCV_{OUT}$  |       |       |       |               |
|   | -40°C $\leq T_A \leq$ +105°C                             |       | 3     | 10    | ppm/°C        |
| $V_{REF}$ Line Regulation                 |  |       | 1.2   | 5     | ppm/V         |
| $V_{REF}$ Load Regulation                 |  |       | 3     | 8     | ppm/mA        |
| $V_{REF}$ Noise                           |  |       | 9     |       | $\mu V_{RMS}$ |
| Output Voltage Hysteresis <sup>4</sup>    | $\Delta V_{OUT\_HYS}$                                    |       |       |       |               |
|   | $\Delta T = 25^\circ C$ to $-40^\circ C$ to $25^\circ C$ |       | 43    |       | ppm           |
|   | $\Delta T = 25^\circ C$ to $105^\circ C$ to $25^\circ C$ |       | -50   |       | ppm           |
|   | $\Delta T = -40^\circ C$ to $+105^\circ C$               |       | 8     |       | ppm           |
| LDO CHARACTERISTICS                       |  |       |       |       |               |
| IN_LDO Voltage Range                      |  | 4.5   | 5.0   | 5.5   | V             |
| IN_LDO Supply Current                     | $I_{OUT\_LDO} = 150$ mA                                  |       | 130   | 190   | $\mu A$       |
| OUT_LDO Voltage                           | Internal LDO Output                                      | 3.35  | 3.45  | 3.55  | V             |

## SPECIFICATIONS

Table 2. Electrical Specifications (Continued)

| Parameter   | Test Conditions/Comments  | Min                       | Typ             | Max  | Unit |
|---|---|---------------------------|-----------------|------|------|
| Maximum Output Current                              |   |                           | 150             |      | mA   |
| Shutdown Current                                    | IN_LDO = GND  |                           | 0.1             | 1    | μA   |
| Load Regulation                                     | I <sub>OUT_LDO</sub> = 1 mA to 150 mA                               |                           | 0.0005          |      | %/mA |
| Start-Up Time                                       |   |                           | 350             |      | μs   |
| Thermal Shutdown Threshold                          |   |                           | 150             |      | °C   |
| Thermal Shutdown Hysteresis                         |   |                           | 15              |      | °C   |
| DIGITAL INPUTS (SCLK, SDI, $\overline{\text{CS}}$ ) | Logic levels  |                           |                 |      |      |
| Input Voltage Low (V <sub>IL</sub> )                | V <sub>LOGIC</sub> < 2.3 V  |                           |                 | 0.45 | V    |
|   | V <sub>LOGIC</sub> ≥ 2.3 V  |                           |                 | 0.7  | V    |
| Input Voltage High (V <sub>IH</sub> )               | V <sub>LOGIC</sub> < 2.3 V  | V <sub>LOGIC</sub> - 0.45 |                 |      | V    |
|   | V <sub>LOGIC</sub> ≥ 2.3 V  | 0.8 × V <sub>LOGIC</sub>  |                 |      | V    |
| Input Current Low (I <sub>IL</sub> )                |   | -1                        |                 | +1   | μA   |
| Input Current High (I <sub>IH</sub> )               |   | -1                        |                 | +1   | μA   |
| DIGITAL OUTPUTS (SDOA, SDOB, SDOC, SDOD/ALERT)      |   |                           |                 |      |      |
| Output Coding                                       |   |                           | Twos complement |      | Bits |
| Output Low Voltage (V <sub>OL</sub> )               | Current sink (I <sub>SINK</sub> ) = +300 μA                         |                           |                 | 0.4  | V    |
| Output High Voltage (V <sub>OH</sub> )              | Current source (I <sub>SOURCE</sub> ) = -300 μA                     | V <sub>LOGIC</sub> - 0.3  |                 |      | V    |
| Floating-State Leakage Current                      |   |                           |                 | ±1   | μA   |
| Floating-State Output Capacitance                   |   |                           | 10              |      | pF   |
| POWER-DOWN/MODE SIGNALING                           | $\overline{\text{PD\_FDA}}$ /MODE_FDA                               |                           |                 |      |      |
| Low   | Disabled, low-power mode  |                           | <1              |      | V    |
| High  | Enabled, full power mode  |                           | >1.5            |      | V    |
| POWER SUPPLY REQUIREMENTS                           |   |                           |                 |      |      |
| Operating Voltage Range                             |   |                           |                 |      |      |
| V <sub>CC</sub>                                     |   | 3.4                       |                 | 3.6  | V    |
| V <sub>LOGIC</sub>                                  |   | 1.65                      |                 | 3.6  | V    |
| V <sub>S+</sub> <sup>5</sup>                        |   | 4.5                       | 5.0             | 5.5  | V    |
| V <sub>S-</sub>                                     |   | -5                        |                 | 0    | V    |
| ADAQ4380-4 Current Draw                             | V <sub>CC</sub> = V <sub>LOGIC</sub> = 3.45 V, V <sub>S</sub> = 5 V |                           |                 |      |      |
| I <sub>VCC</sub>                                    | V <sub>CC</sub> supply current                                      |                           |                 |      |      |
|   | Normal mode (Dynamic)   |                           | 38              | 42   | mA   |
|   | Normal mode (Static)  |                           | 1.8             | 2.3  | mA   |
|   | Shutdown mode   |                           | 101             | 200  | μA   |
| I <sub>VLOGIC</sub>                                 | V <sub>LOGIC</sub> supply current                                   |                           |                 |      |      |
|   | Normal mode (Dynamic)   |                           | 7.3             | 9    | mA   |
|   | Normal mode (Static)  |                           | 10              | 200  | nA   |
|   | Shutdown mode   |                           | 10              | 200  | nA   |
| I <sub>VS+</sub> /I <sub>VS-</sub>                  | V <sub>S+</sub> /V <sub>S-</sub> supply current                     |                           |                 |      |      |
|   | Full power mode   |                           | 25              | 28   | mA   |
|   | Low-power mode  |                           | 15              | 18   | mA   |
| ADAQ4380-4 Power Dissipation                        | V <sub>CC</sub> = V <sub>LOGIC</sub> = 3.45 V, V <sub>S</sub> = 5 V |                           |                 |      |      |
| P <sub>VCC</sub>                                    | V <sub>CC</sub> power   |                           |                 |      |      |
|   | Normal mode (Dynamic)   |                           | 130             | 155  | mW   |
|   | Normal mode (Static)  |                           | 6               | 8    | mW   |
| P <sub>VLOGIC</sub>                                 | V <sub>LOGIC</sub> power  |                           |                 |      |      |
|   | Normal mode (Dynamic)   |                           | 25              | 28   | mW   |
|   | Normal mode (Static)  |                           | 36              | 720  | nW   |

## SPECIFICATIONS

Table 2. Electrical Specifications (Continued)

| Parameter               | Test Conditions/Comments            | Min | Typ | Max  | Unit |
|-------------------------|-------------------------------------|-----|-----|------|------|
| $P_{VS+/VS-}$           | $V_{S+}/V_{S-}$ power               |     |     |      |      |
|                         | Full power mode                     |     | 125 | 135  | mW   |
| Total Power Dissipation | Low-power mode                      |     | 75  | 80   | mW   |
|                         | ADAQ4380-4 power dissipation        |     |     |      |      |
|                         | Dynamic, full power mode            |     | 280 | 318  | mW   |
|                         | Dynamic, low-power mode             |     | 230 | 263  | mW   |
| TEMPERATURE RANGE       |                                     |     |     |      |      |
| Specified Performance   | $T_{MIN}$ to $T_{MAX}$ <sup>6</sup> | -40 |     | +105 | °C   |

<sup>1</sup> The absolute differential input ranges,  $V_{IN}$ , must be within the allowed input common-mode range as per Figure 48 to Figure 55.  $V_{IN}$  is dependent on the  $V_{S+}$  and  $V_{S-}$  supply rails used.

<sup>2</sup> Limit the absolute differential input range,  $V_{IN}$ , to 95% of full scale to allow enough footroom for the ADC driver with  $V_S = 0$  V to achieve specified performance.

<sup>3</sup> All AC specifications expressed in decibels are referred to full-scale input range (FSR) and are tested with an input signal of 0.5 dB below full scale, unless otherwise specified.

<sup>4</sup> Hysteresis in output voltage is created by package stress that differs depending on whether the IC is previously at a higher or lower temperature. Output voltage is always measured at 25°C, but the IC is cycled to the hot or cold temperature limit before successive measurements. Hysteresis measures the maximum output change for the averages of three hot or cold temperature cycles. For instruments that are stored at well controlled temperatures (within 20°C or 30°C of operational temperature), it is usually not a dominant error source. Typical hysteresis is the worst case of 25°C to cold to 25°C or 25°C to hot to 25°C, preconditioned by one thermal cycle.

<sup>5</sup> Maximum operating supply voltage,  $V_S$  ( $V_{S+} - V_{S-}$ ) must not exceed 10 V.

<sup>6</sup> The ADAQ4380-4 is rated for performance over extended industrial temperature range,  $T_{CASE} = -40^{\circ}\text{C}$  to  $+105^{\circ}\text{C}$ .

## SPECIFICATIONS

## TIMING SPECIFICATIONS

$V_{CC} = 3.0\text{ V to }3.6\text{ V}$ ,  $V_{LOGIC} = 1.65\text{ V to }3.6\text{ V}$ ,  $V_{REF} = 3.3\text{ V}$ ,  $T_A = -40^{\circ}\text{C to }+105^{\circ}\text{C}$ ,  $C_{LOAD\_SDO} = 30\text{ pF}$ , unless otherwise noted.

Table 3. Digital Interface Timing

| Parameter         | Min                                   | Typ | Max | Unit          | Description  |
|-------------------|---------------------------------------|-----|-----|---------------|--|
| $t_{CYC}$         | 250                                   |     |     | ns            | Time between conversions   |
| $t_{SCLKED}$      | 5                                     |     |     | ns            | $\overline{CS}$ falling edge to first SCLK falling edge                                |
| $t_{SCLK}$        | 12.5                                  |     |     | ns            | SCLK period  |
| $t_{SCLKH}$       | 5.5                                   |     |     | ns            | SCLK high time   |
| $t_{SCLKL}$       | 5.5                                   |     |     | ns            | SCLK low time  |
| $t_{CSH}$         | 10                                    |     |     | ns            | $\overline{CS}$ pulse width  |
| $t_{QUIET}$       | 10                                    |     |     | ns            | Interface quiet time prior to conversion   |
| $t_{SDOEN}$       |                                       |     |     |               | $\overline{CS}$ low to SDOx enabled  |
|                   |                                       |     | 5.5 | ns            | $V_{LOGIC} \geq 1.75\text{ V}$   |
|                   |                                       |     | 7.4 | ns            | $V_{LOGIC} < 1.75\text{ V}$  |
| $t_{SDOH}$        | 3                                     |     |     | ns            | SCLK rising edge to SDOx hold time   |
| $t_{SDOS}$        |                                       |     |     |               | SCLK rising edge to SDOx setup time  |
|                   |                                       |     | 5   | ns            | $V_{LOGIC} \geq 2.1\text{ V}$  |
|                   |                                       |     | 7.2 | ns            | $1.65\text{ V} \leq V_{LOGIC} < 2.1\text{ V}$  |
| $t_{SDOT}$        |                                       |     | 8   | ns            | $\overline{CS}$ rising edge to SDOx high impedance                                     |
| $t_{SDIS}$        | 4                                     |     |     | ns            | SDI setup time prior to SCLK falling edge  |
| $t_{SDIH}$        | 4                                     |     |     | ns            | SDI hold time after SCLK falling edge  |
| $t_{SCLKCS}$      | 0                                     |     |     | ns            | SCLK rising edge to $\overline{CS}$ rising edge  |
| $t_{CONVERT}$     |                                       |     | 190 | ns            | Conversion time  |
| $t_{ACQUIRE}$     | 110                                   |     |     | ns            | Acquire time   |
| $t_{RESET}$       |                                       | 250 |     | ns            | Valid time to start conversion after soft reset  |
|                   |                                       | 800 |     | ns            | Valid time to start conversion after hard reset  |
| $t_{POWER-UP}$    |                                       |     |     |               | Supply active to conversion  |
|                   |                                       |     | 5   | ms            | First conversion allowed   |
|                   |                                       |     | 5   | ms            | Settled to within 1%   |
| $t_{REGWRITE}$    |                                       |     | 5   | ms            | Supply active to register read write access allowed                                    |
| $t_{STARTUP}$     |                                       |     |     |               | Exiting shutdown mode to conversion  |
|                   |                                       |     | 10  | $\mu\text{s}$ | Settled to within 1%   |
| $t_{CONVERT0}$    | 6                                     | 8   | 10  | ns            | Conversion time for first sample in OS normal mode                                     |
| $t_{CONVERTx}$    | $t_{CONVERT0} + (500 \times (x - 1))$ |     |     | ns            | Conversion time for $x^{\text{th}}$ sample in OS normal mode                           |
| $t_{ALERTS}$      |                                       |     | 220 | ns            | Time from $\overline{CS}$ to $\overline{ALERT}$ indication                             |
| $t_{ALERTC}$      |                                       |     | 10  | ns            | Time from $\overline{CS}$ to $\overline{ALERT}$ clear                                  |
| $t_{ALERTS\_NOS}$ |                                       |     | 20  | ns            | Time from internal conversion with exceeded threshold to $\overline{ALERT}$ indication |



SPECIFICATIONS

Timing Diagrams

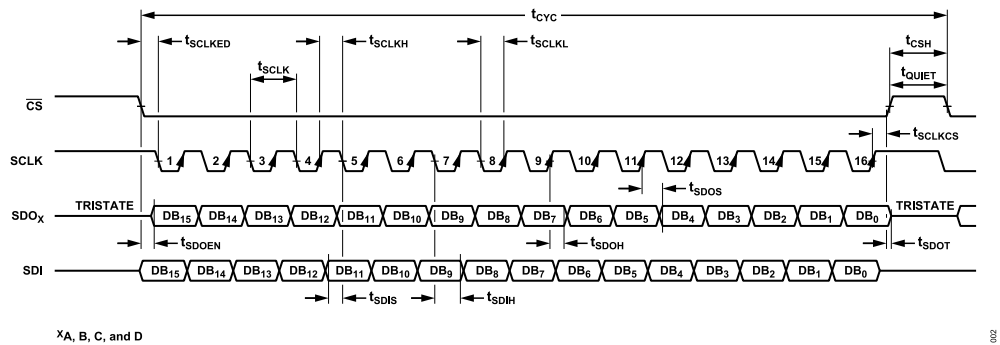


Figure 2. Serial Interface Timing Diagram

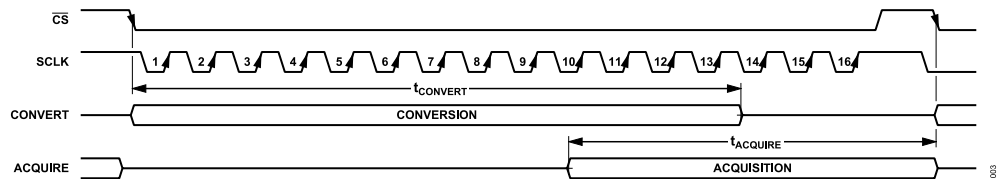


Figure 3. Internal Conversion Acquire Timing

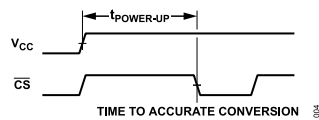


Figure 4. Power-Up Time to Conversion

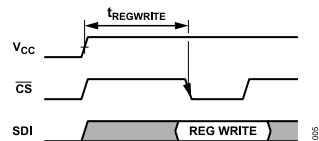


Figure 5. Power-Up Time to Register Read Write Access

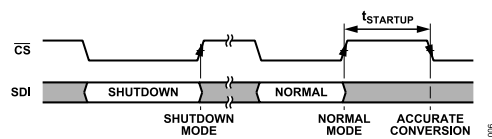


Figure 6. Shutdown Mode to Normal Mode Timing

SPECIFICATIONS

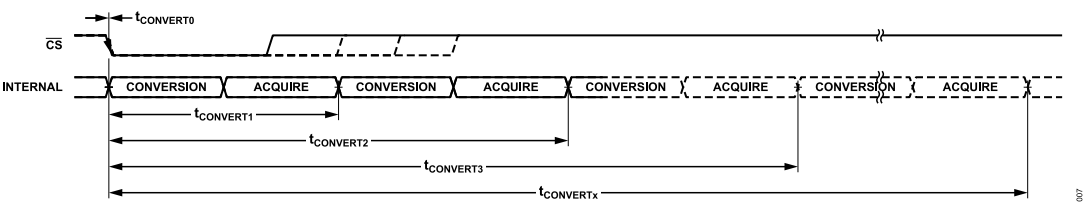


Figure 7. Conversion Timing During OS Normal Mode

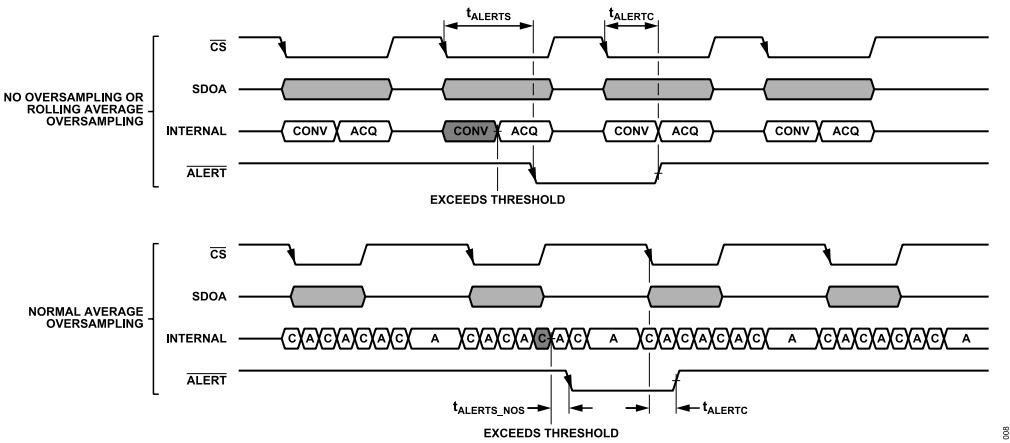


Figure 8. ALERT Timing

## ABSOLUTE MAXIMUM RATINGS

Table 4. Absolute Maximum Ratings

| Parameter  | Rating                               |
|--|--------------------------------------|
| Analog Inputs<br>IN <sub>X</sub> 1+, IN <sub>X</sub> 1-, IN <sub>X</sub> 2+, IN <sub>X</sub> 2- to GND | -12.5 V to +12.5 V or $\pm 10$ mA    |
| Supply Voltages  |                                      |
| V <sub>S</sub>   | 11 V                                 |
| IN_LDO to GND  | -0.3 V to +6.5 V                     |
| EN_LDO to GND  | -0.3 V to +6.5 V                     |
| V <sub>LOGIC</sub> to GND  | -0.3 V to +4 V                       |
| V <sub>CC</sub> to GND   | -0.3 V to +4 V                       |
| REFIN to GND   | -0.3 V to +38 V                      |
| Digital Inputs to GND  | -0.3 V to V <sub>LOGIC</sub> + 0.3 V |
| Digital Outputs to GND   | -0.3 V to V <sub>LOGIC</sub> + 0.3 V |
| Temperature  |                                      |
| Storage Range  | -65°C to +150°C                      |
| Junction   | 125°C                                |
| Lead Soldering   | 260°C reflow as per JEDEC J-STD-020  |

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

## THERMAL RESISTANCE

Thermal performance is directly linked to printed circuit board (PCB) design and operating environment. Careful attention to PCB thermal design is required.

Table 5. Thermal Resistance

| Package Type <sup>1</sup> | $\theta_{JA}$ | $\theta_{JC\_TOP}$ | $\theta_{JC\_BOTTOM}$ | $\theta_{JB}$ | $\Psi_{JT}$ | $\Psi_{JB}$ | Unit |
|---------------------------|---------------|--------------------|-----------------------|---------------|-------------|-------------|------|
| BC-81-7                   | 27.2          | 38.1               | 10.4                  | 11.9          | 5.7         | 12.0        | °C/W |

<sup>1</sup> Test Condition 1: Thermal impedance simulated values are based on use of a 2S2P with vias JEDEC PCB excluding the  $\theta_{JC\_TOP}$ , which uses 1S0P JEDEC PCB.

Thermal resistance values specified in Table 5 are simulated based on JEDEC specs (unless specified otherwise) and should be used in compliance with JESD51-12.

## ELECTROSTATIC DISCHARGE RATINGS

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

Human body model (HBM) per ANSI/ESDA/JEDDEC JS-001.

Field induced charged-device model (FICDM) per ANSI/ESDA/JEDEC JS-002.

### ESD Ratings for ADAQ4380-4

Table 6. ADAQ4380-4, 81-Ball CSP\_BGA

| ESD Model | Withstand Threshold (V) | Class |
|-----------|-------------------------|-------|
| HBM       | $\pm 2000$              | 2     |
| FICDM     | $\pm 500$               | C2B   |

## ESD CAUTION



**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

**ADAQ4380-4**  
TOP VIEW  
(Not to Scale)

|   | 1     | 2      | 3        | 4     | 5      | 6        | 7       | 8      | 9              |
|---|-------|--------|----------|-------|--------|----------|---------|--------|----------------|
| A | GND   | INC1+  | INC1-    | IND2+ | IND2-  | IND1+    | IND1-   | GND    | GND            |
| B | GND   | OUTC-  | OUTC+    | SJD+  | SJD-   | OUTD-    | OUTD+   | GND    | SDOD/<br>ALERT |
| C | INC2- | SJC-   | VS+      | VS+   | IN_LDO | EN_LDO   | GND     | VLOGIC | SDOC           |
| D | INC2+ | SJC+   | VS+      | VS+   | IN_LDO | OUT_LDO  | OUT_LDO | GND    | SCLK           |
| E | GND   | PD_FDA | MODE_FDA | GND   | GND    | DNC      | VCC     | GND    | SDI            |
| F | INB2+ | SJB+   | VS-      | VS-   | DNC    | DNC      | REFIN   | GND    | SDOB           |
| G | INB2- | SJB-   | VS-      | VS-   | GND    | REFSENSE | DNC     | GND    | SDOA           |
| H | GND   | OUTB-  | OUTB+    | SJA+  | SJA-   | OUTA-    | OUTA+   | GND    | CS             |
| J | GND   | INB1+  | INB1-    | INA2+ | INA2-  | INA1+    | INA1-   | GND    | GND            |

## NOTES

1. DNC = DO NOT CONNECT. LEAVE THESE PINS FLOATING/UNCONNECTED.

000

Figure 9. Pin Configuration

Table 7. Pin Function Descriptions

| Pin Number   | Mnemonic   | Type <sup>1</sup> | Description   |
|--|------------|-------------------|---|
| A1, A8, A9, B1, B8, C7, D8, E1, E4, E5, E8, F8, G5, G8, H1, H8, J1, J8, J9 | GND        | P                 | Power Supply Ground.  |
| A2   | INC1+      | AI                | Channel C Positive Input to 1.62 kΩ Gain Resistor Network.  |
| A3   | INC1-      | AI                | Channel C Negative Input to 1.62 kΩ Gain Resistor Network.  |
| A4   | IND2+      | AI                | Channel D Positive Input to 2.70 kΩ Gain Resistor Network.  |
| A5   | IND2-      | AI                | Channel D Negative Input to 2.70 kΩ Gain Resistor Network.  |
| A6   | IND1+      | AI                | Channel D Positive Input to 1.62 kΩ Gain Resistor Network.  |
| A7   | IND1-      | AI                | Channel D Negative Input to 1.62 kΩ Gain Resistor Network.  |
| B2   | OUTC-      | AO <sup>2</sup>   | ADC Driver Negative Output for Channel C.   |
| B3   | OUTC+      | AO <sup>2</sup>   | ADC Driver Positive Output for Channel C.   |
| B4   | SJD+       | AI                | ADC Driver Positive Input Summing Node for Channel D.   |
| B5   | SJD-       | AI                | ADC Driver Negative Input Summing Node for Channel D.   |
| B6   | OUTD-      | AO <sup>2</sup>   | ADC Driver Negative Output for Channel D.   |
| B7   | OUTD+      | AO <sup>2</sup>   | ADC Driver Positive Output for Channel D.   |
| B9   | SDOD/ALERT | DO                | Serial Data Output D/ALERT. This pin functions as a serial data output to or alert indication output. SDOD. This pin functions as a serial data output pin to access the conversion results. ALERT. This pin operates as an alert pin going low to indicate that a conversion result has exceeded a configured threshold. |
| C1   | INC2-      | AI                | Channel C Negative Input to 2.70 kΩ Gain Resistor Network.  |
| C2   | SJC-       | AI                | ADC Driver Negative Input Summing Node for Channel C.   |
| C3, C4, D3, D4   | VS+        | P                 | Amplifiers Positive Supply. These pins are decoupled to ground internally. Additional decoupling capacitors may not be necessary.   |
| C5, D5   | IN_LDO     | P                 | Integrated LDO Input Voltage. Connect to VS+ (or 3.6 V < IN_LDO < 5.5 V). This pin is decoupled to ground internally. Additional decoupling capacitors may not be necessary.  |
| C6   | EN_LDO     | P                 | LDO enable. Connect to IN_LDO or VS+ to enable the internal LDO. Connect to GND if otherwise.   |

## PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

Table 7. Pin Function Descriptions (Continued)

| Pin Number     | Mnemonic                    | Type <sup>1</sup> | Description   |
|----------------|-----------------------------|-------------------|---|
| C8             | VLOGIC                      | P                 | ADC Logic Interface Supply Voltage. This pin is decoupled to ground internally. Additional decoupling capacitors may not be necessary.  |
| C9             | SDOC                        | DO                | Serial Data Output C. This pin functions as a serial data output pin to access the conversion results and register contents.  |
| D1             | INC2+                       | AI                | Channel C Positive Input to 2.70 kΩ Gain Resistor Network.  |
| D2             | SJC+                        | AI                | ADC Driver Positive Input Summing Node for Channel C.   |
| D6, D7         | OUT_LDO                     | P                 | Integrated LDO Output Voltage. The voltage at this pin is 3.45 V typical.   |
| D9             | SCLK                        | DI                | Serial Clock Input. This serial clock input is for data transfers to and from the ADC.  |
| E2             | $\overline{\text{PD\_FDA}}$ | P                 | Active low. Connect this pin to GND to power down (disable) the ADC Drivers. Connect VS+ for normal operation.  |
| E3             | MODE_FDA                    | P                 | Power Mode for ADC Drivers. Connect to VS+ for full power mode. Connect to GND to enter low power mode.   |
| E6, F5, F6, G7 | DNC                         | N/A <sup>3</sup>  | Do Not Connect. Leave these pins floating/unconnected.  |
| E7             | VCC                         | P                 | ADC Analog Supply Voltage. This pin is decoupled to ground internally. Additional decoupling capacitors may not be necessary.   |
| E9             | SDI                         | DI                | Serial Data Input. This input provides the data written to the on-chip control registers.   |
| F1             | INB2+                       | AI                | Channel B Positive Input to 2.70 kΩ Gain Resistor Network.  |
| F2             | SJB+                        | AI                | ADC Driver Positive Input Summing Node for Channel B.   |
| F3, F4, G3, G4 | VS-                         | P                 | Amplifiers Negative Supply. These pins are decoupled to ground internally. Additional decoupling capacitors may not be necessary.   |
| F7             | REFIN                       | P                 | Internal Reference Supply Voltage. Connect to VS+ for normal operation. This pin is decoupled to ground internally. Additional decoupling capacitors may not be necessary.  |
| F9             | SDOB                        | DO                | Serial Data Output B. This pin functions as a serial data output pin to access the conversion results and register contents.  |
| G1             | INB2-                       | AI                | Channel B Negative Input to 2.70 kΩ Gain Resistor Network.  |
| G2             | SJB-                        | AI                | ADC Driver Negative Input Summing Node for Channel B.   |
| G6             | REFSENSE                    | AO <sup>2</sup>   | Reference Output Sense pin.<br>For accurate gain calibration, use this pin to measure the actual level of the internal 3.3 V reference. If not utilized, leave this pin floating and unconnected.<br>Capacitive load connected to this pin must not exceed 1 μF to ensure system stability. |
| G9             | SDOA                        | DO                | Serial Data Output A. This pin functions as a serial data output pin to access the conversion results and register contents.  |
| H2             | OUTB-                       | AO <sup>2</sup>   | ADC Driver Negative Output for Channel B.   |
| H3             | OUTB+                       | AO <sup>2</sup>   | ADC Driver Positive Output for Channel B.   |
| H4             | SJA+                        | AI                | ADC Driver Positive Input Summing Node for Channel A.   |
| H5             | SJA-                        | AI                | ADC Driver Negative Input Summing Node for Channel A.   |
| H6             | OUTA-                       | AO <sup>2</sup>   | ADC Driver Negative Output for Channel A.   |
| H7             | OUTA+                       | AO <sup>2</sup>   | ADC Driver Positive Output for Channel A.   |
| H9             | $\overline{\text{CS}}$      | DI                | Chip Select Input. Active low, logic input. This input provides the dual function of initiating conversions on the ADAQ4380-4 and framing the serial data transfer.   |
| J2             | INB1+                       | AI                | Channel B Positive Input to 1.62 kΩ Gain Resistor Network.  |
| J3             | INB1-                       | AI                | Channel B Negative Input to 1.62 kΩ Gain Resistor Network.  |
| J4             | INA2+                       | AI                | Channel A Positive Input to 2.70 kΩ Gain Resistor Network.  |
| J5             | INA2-                       | AI                | Channel A Negative Input to 2.70 kΩ Gain Resistor Network.  |
| J6             | INA1+                       | AI                | Channel A Positive Input to 1.62 kΩ Gain Resistor Network.  |
| J7             | INA1-                       | AI                | Channel A Negative Input to 1.62 kΩ Gain Resistor Network.  |

<sup>1</sup> AI is analog input, AO is analog output, P is power, DI is digital input, and DO is digital output.<sup>2</sup> Analog output pins are for voltage monitoring/measurement, and setting the gain of ADAQ4380-4 only. These pins must not be driven externally.<sup>3</sup> N/A means not applicable.

## TYPICAL PERFORMANCE CHARACTERISTICS

$V_S = \text{REFIN} = \text{IN\_LDO} = \text{EN\_LDO} = 5\text{ V}$ ,  $V_{CC} = V_{\text{LOGIC}} = 3.45\text{ V}$ , reference voltage ( $V_{\text{REF}}$ ) = 3.3 V internal,  $f_{\text{SAMPLE}} = 4\text{ MSPS}$ , fully differential input configuration, full power mode,  $T_A = 25^\circ\text{C}$ , no oversampling, unless otherwise noted.

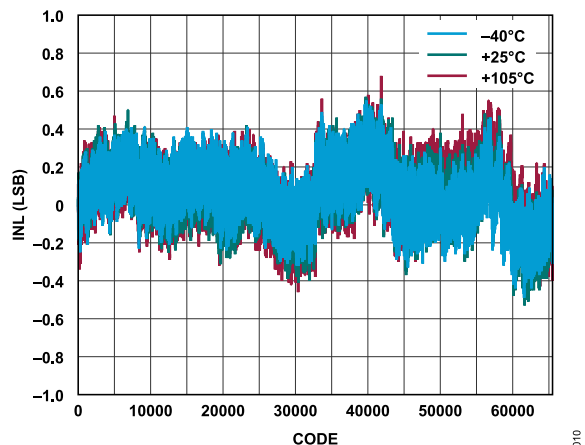


Figure 10. INL vs. Code for Various Temperature, Gain = 1.0

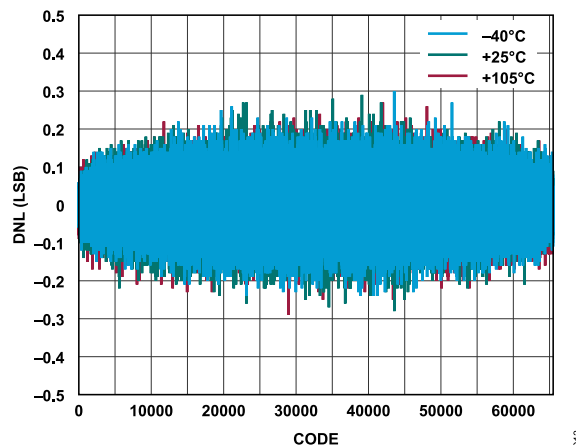


Figure 13. DNL vs. Code for Various Temperature, Gain = 1.0

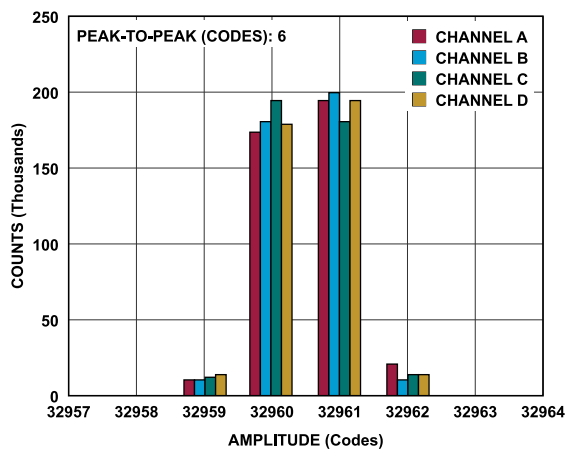


Figure 11. Histogram of a DC Input at the Code Transition

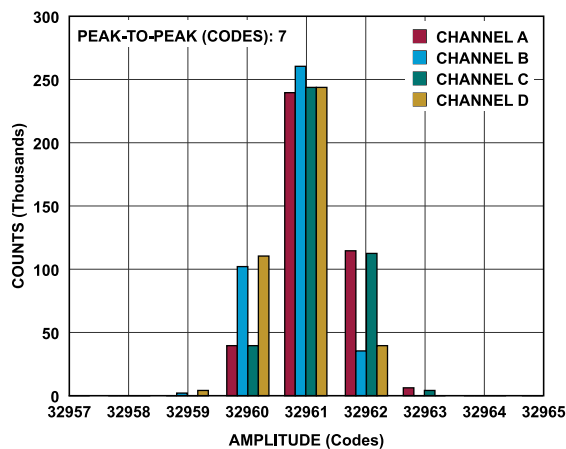


Figure 14. Histogram of a DC Input at the Code Center

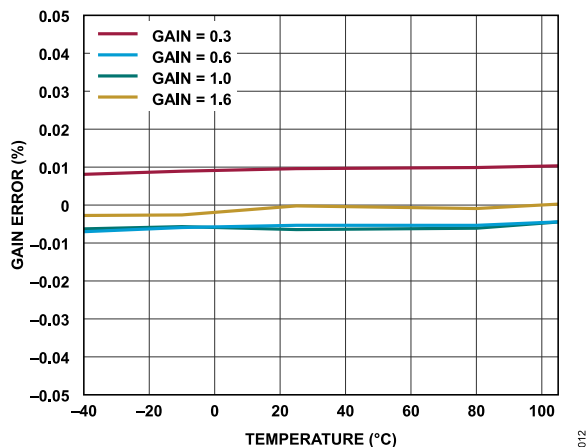


Figure 12. Gain Error vs. Temperature

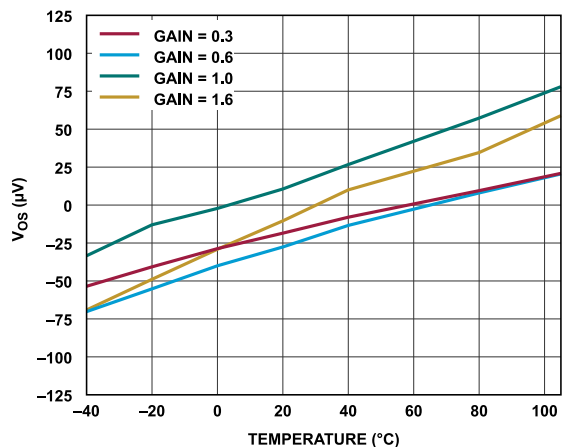


Figure 15. Offset Error vs. Temperature

## TYPICAL PERFORMANCE CHARACTERISTICS

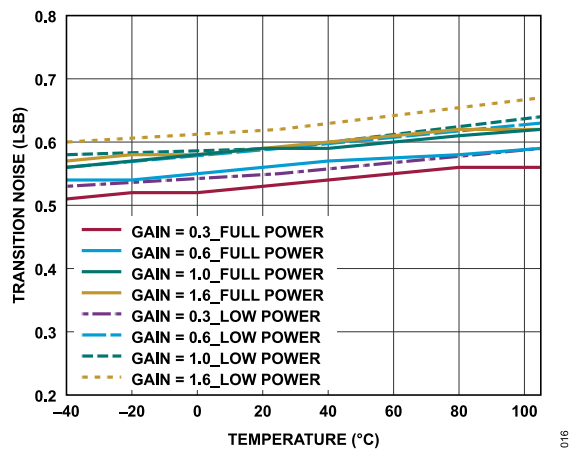


Figure 16. Transition Noise vs. Temperature

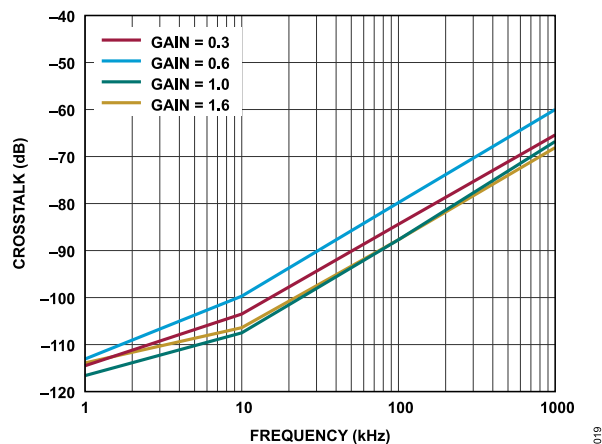


Figure 19. Channel-to-Channel Isolation vs. Frequency

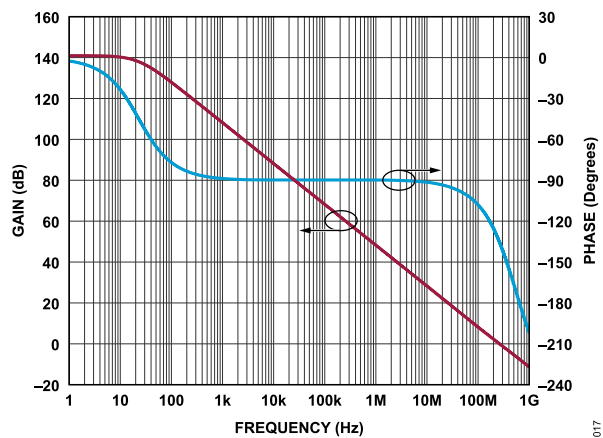


Figure 17. ADC Driver Open-Loop Gain and Phase vs. Frequency

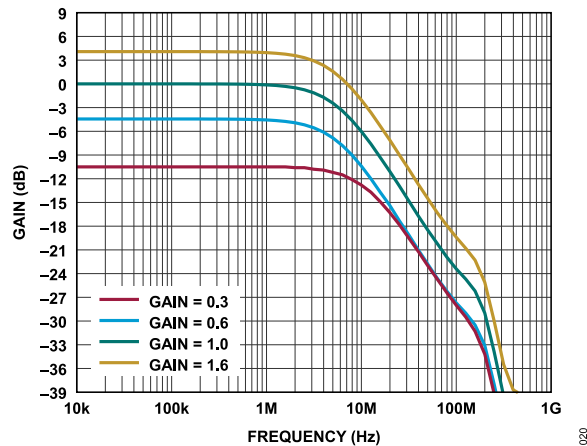


Figure 20. ADC Driver Closed-Loop Gain vs. Frequency

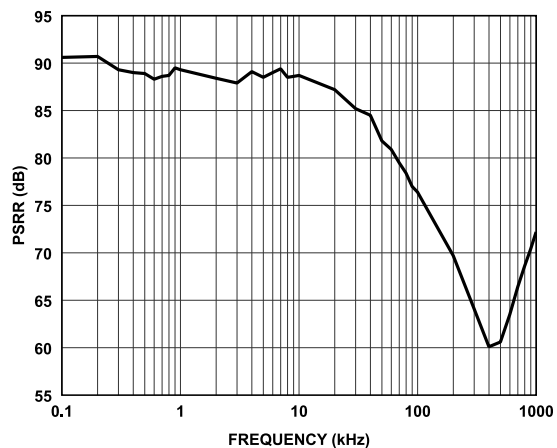


Figure 18. PSRR vs. Frequency

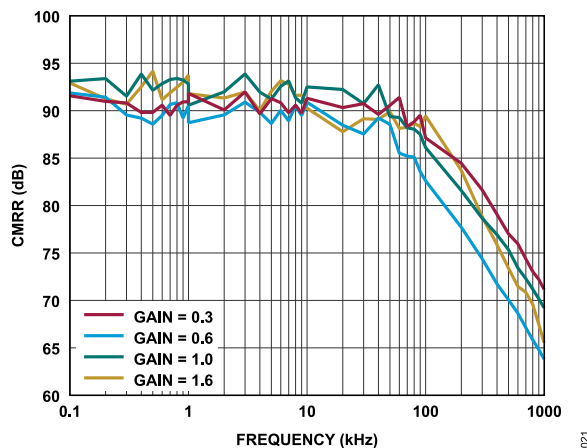


Figure 21. CMRR vs. Frequency

## TYPICAL PERFORMANCE CHARACTERISTICS

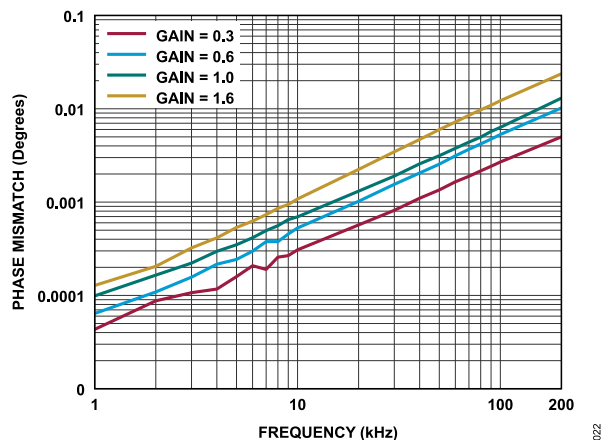


Figure 22. Channel-to-Channel Phase Matching vs. Frequency

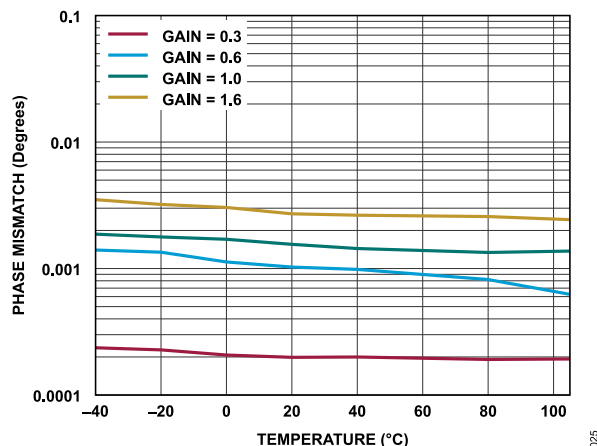
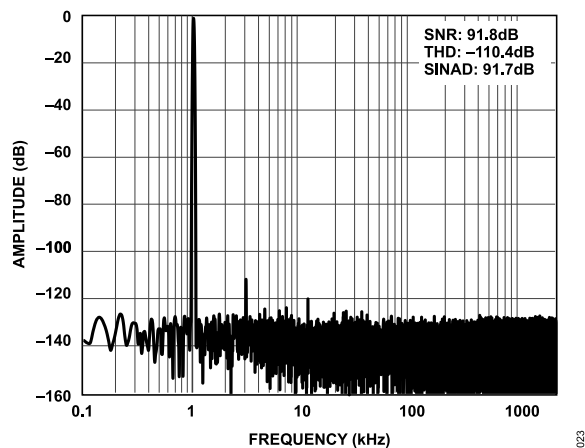
Figure 25. Channel-to-Channel Phase Matching vs. Temperature,  $f_{IN} = 20$  kHz

Figure 23. 1 kHz, -0.5 dBFS Input tone FFT, Gain = 0.3, Differential Input, Full Power

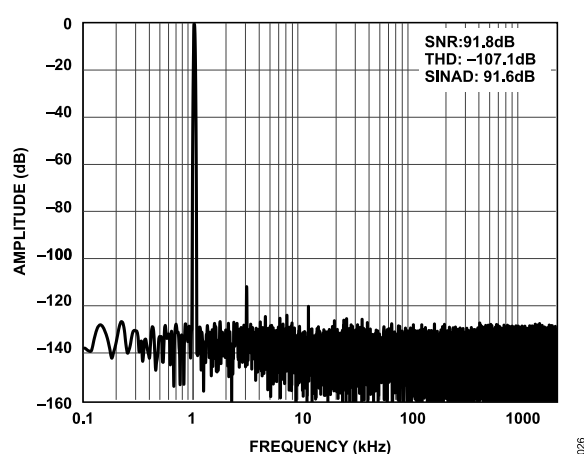


Figure 26. 1 kHz, -0.5 dBFS Input tone FFT, Gain = 0.3, Single-Ended Input, Full Power

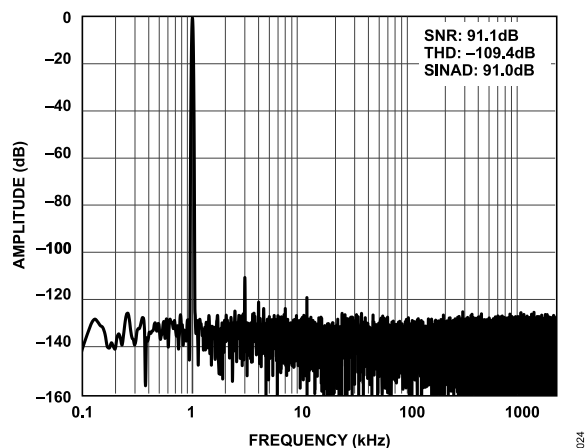


Figure 24. 1 kHz, -0.5 dBFS Input tone FFT, Gain = 0.3, Differential Input, Low Power

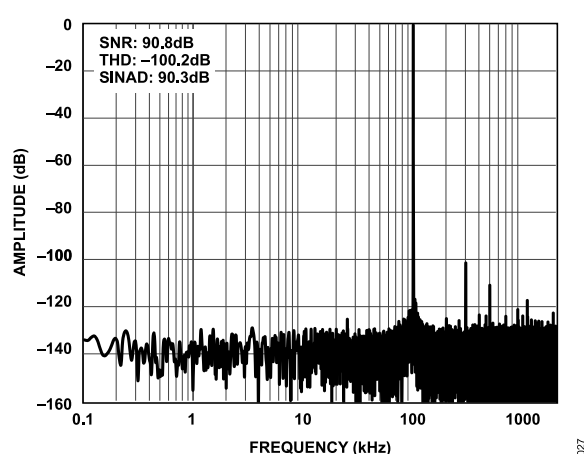


Figure 27. 100 kHz, -0.5 dBFS Input tone FFT, Gain = 0.3, Differential Input, Full Power



## TYPICAL PERFORMANCE CHARACTERISTICS

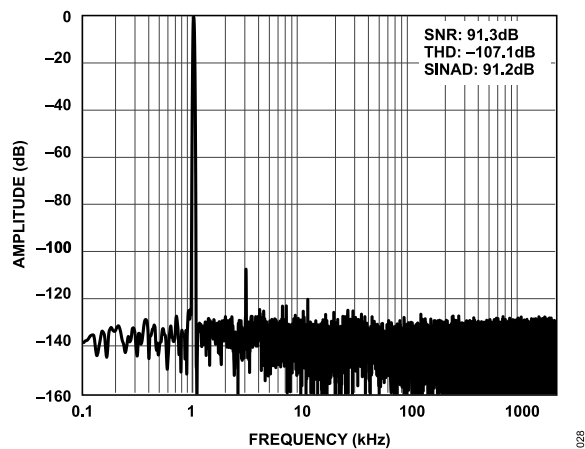


Figure 28. 1 kHz, -0.5 dBFS Input tone FFT, Gain = 0.6, Differential Input, Full Power

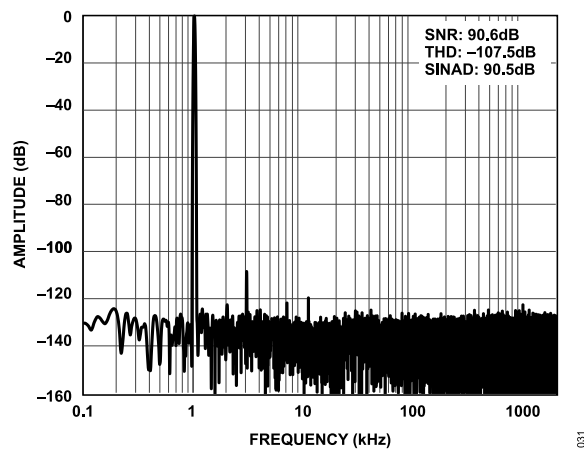


Figure 31. 1 kHz, -0.5 dBFS Input tone FFT, Gain = 0.6, Single-Ended Input, Low Power

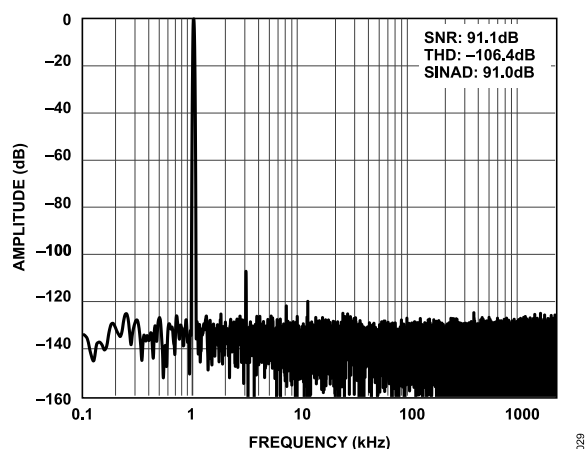


Figure 29. 1 kHz, -0.5 dBFS Input tone FFT, Gain = 1.0, Differential Input, Full Power

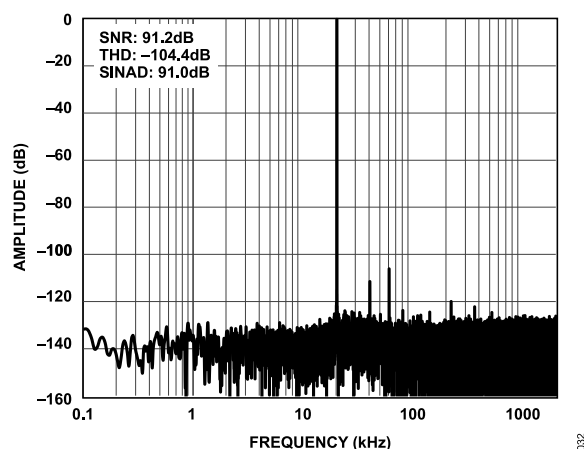


Figure 32. 20 kHz, -0.5 dBFS Input tone FFT, Gain = 1.0, Single-Ended Input, Full Power

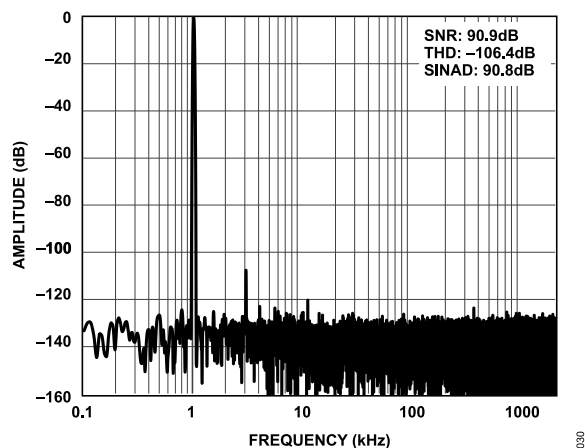


Figure 30. 1 kHz, -0.5 dBFS Input tone FFT, Gain = 1.6, Differential Input, Full Power

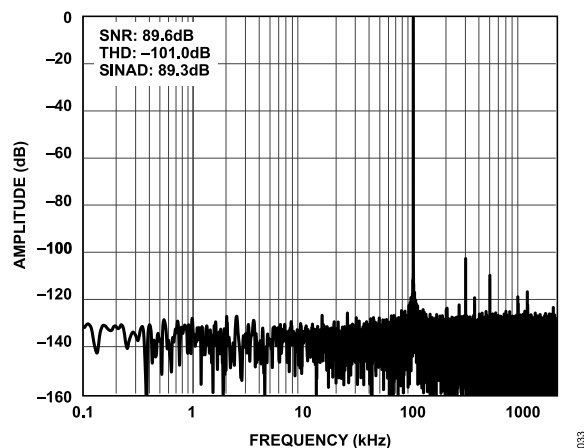


Figure 33. 100 kHz, -0.5 dBFS Input tone FFT, Gain = 1.6, Differential Input, Low Power

## TYPICAL PERFORMANCE CHARACTERISTICS

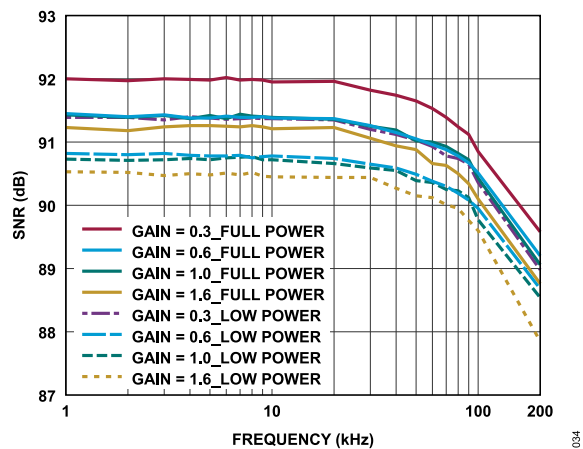


Figure 34. SNR vs. Frequency

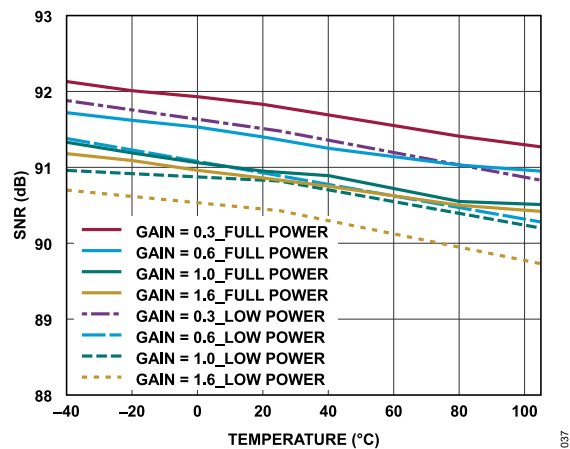
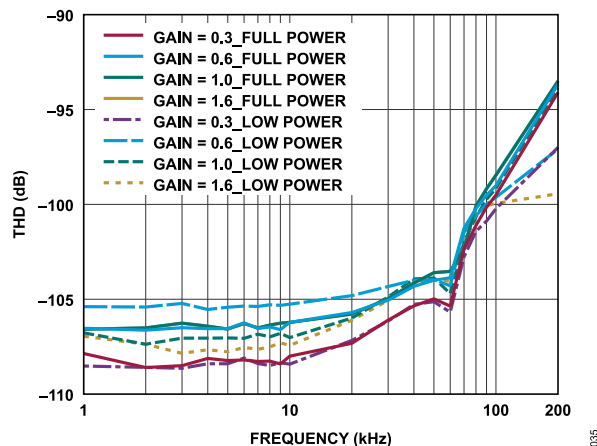
Figure 37. SNR vs. Temperature,  $f_{IN} = 1$  kHz

Figure 35. THD vs. Frequency

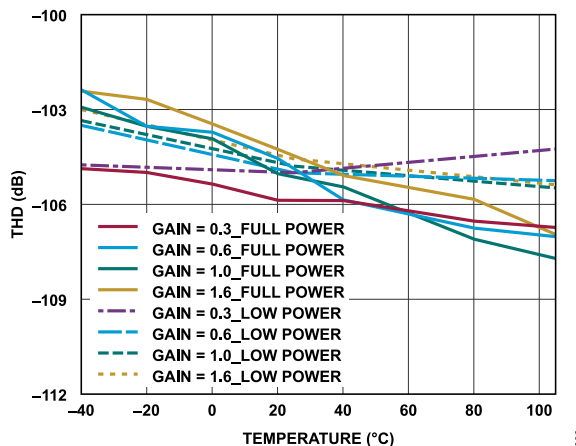
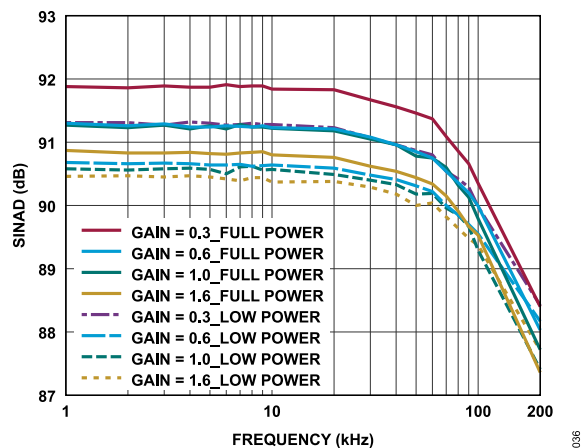
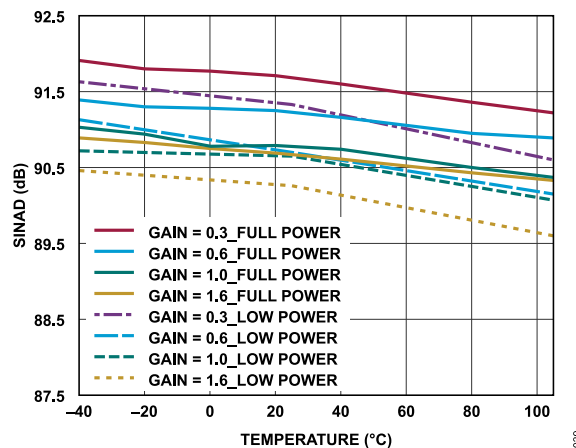
Figure 38. THD vs. Temperature,  $f_{IN} = 1$  kHz

Figure 36. SINAD vs. Frequency

Figure 39. SINAD vs. Temperature,  $f_{IN} = 1$  kHz

## TYPICAL PERFORMANCE CHARACTERISTICS

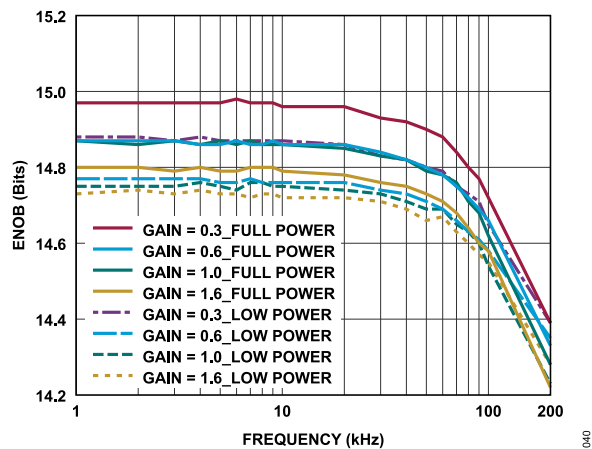


Figure 40. ENOB vs. Frequency

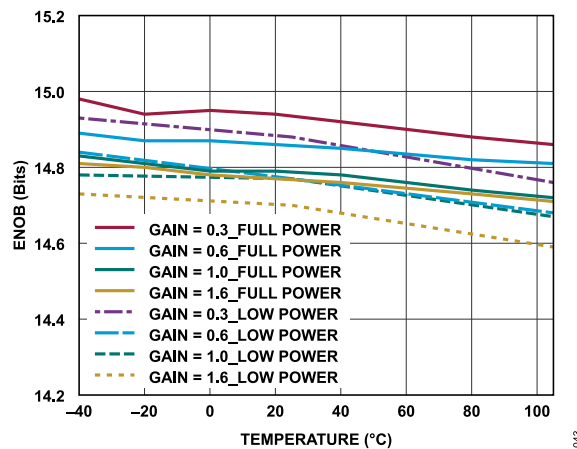
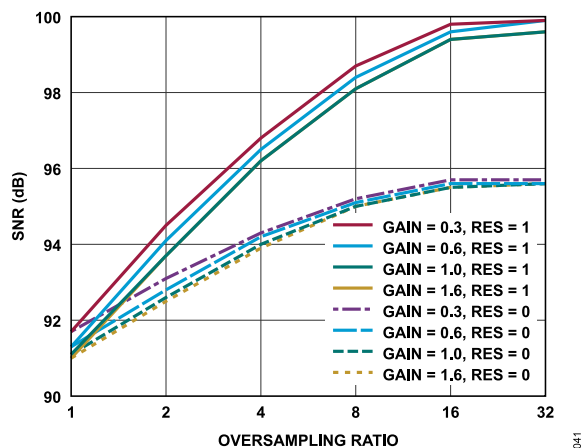
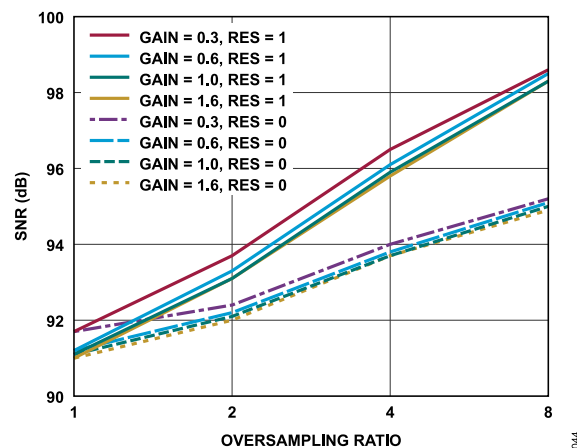
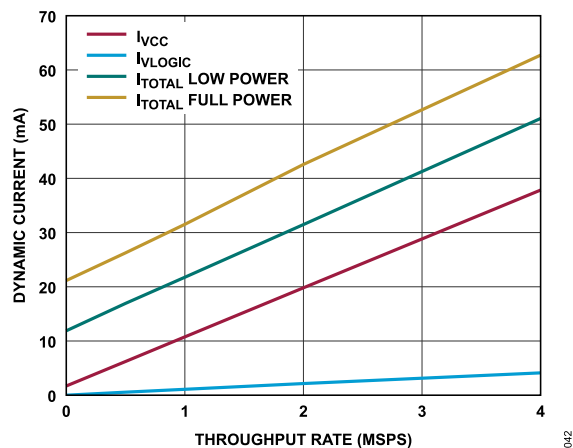
Figure 43. ENOB vs. Temperature,  $f_{IN} = 1$  kHzFigure 41. SNR vs. Normal Average Oversampling,  $f_{IN} = 1$  kHzFigure 44. SNR vs. Rolling Average Oversampling,  $f_{IN} = 1$  kHz

Figure 42. Dynamic Current vs. Throughput Rate

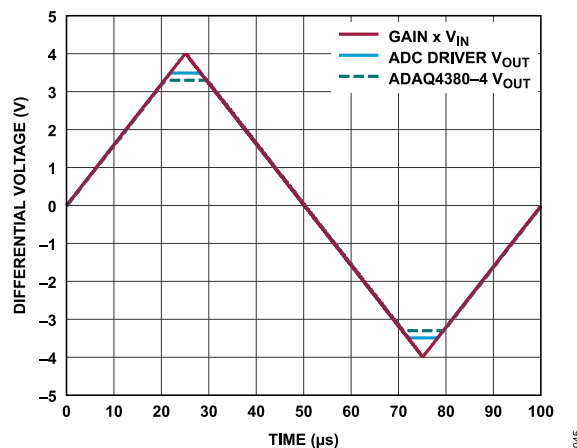


Figure 45. Output Overdrive Recovery, Gain = 0.6

## TERMINOLOGY

### Differential Voltage

Differential voltage is the difference between two node voltages. For example, the differential input voltage (or equivalently, input differential mode voltage) is defined as:

$$V_{IN, dm} = V_{AINA+} - V_{AINA-} \quad (1)$$

where  $V_{AINA+}$  and  $V_{AINA-}$  refer to the voltages at the AINA+ and AINA- terminals with respect to a common reference.

### Common-Mode Voltage (CMV)

Common-mode voltage is the average of two node voltages. The input common-mode voltage is defined as:

$$V_{IN, cm} = (V_{AINA+} + V_{AINA-}) / 2 \quad (2)$$

### Integral Nonlinearity (INL)

INL is the deviation of each individual code from a line drawn from negative full scale through positive full scale. The point used as negative full scale occurs  $\frac{1}{2}$  LSB before the first code transition. Positive full scale is defined as a level  $\frac{1}{2}$  LSB beyond the last code transition. The deviation is measured from the middle of each code to the true straight line.

### Differential Nonlinearity (DNL)

In an ideal ADC, code transitions are 1 LSB apart. DNL is the maximum deviation from this ideal value. It is often specified in terms of resolution for which no missing codes are guaranteed.

### Offset Error

The first transition occurs at a level  $\frac{1}{2}$  LSB above analog ground. Offset error is the difference between the ideal mid-scale input voltage (0 V), and the actual voltage producing the mid-scale output code.

### Offset Error Drift

Offset error drift is the ratio of the offset error change due to a temperature change of  $1^{\circ}\text{C}$  and the full-scale code range. Offset error drift is expressed in parts per million per degree Celsius (ppm/ $^{\circ}\text{C}$ ) as follows:

$$\text{Offset Error Drift (ppm}/^{\circ}\text{C}) = 10^6 \times \frac{(\text{Offset Error}_{T_{MAX}} - \text{Offset Error}_{T_{MIN}})}{(T_{MAX} - T_{MIN})} \quad (3)$$

where:

$$T_{MAX} = 105^{\circ}\text{C}.$$

$$T_{MIN} = -40^{\circ}\text{C}.$$

### Gain Error

The first transition (from 100...000 to 100...001) must occur at a level  $\frac{1}{2}$  LSB above nominal negative full scale. The last transition (from 011...110 to 011...111) occurs for an analog voltage  $\frac{1}{2}$  LSB below the nominal full scale. The gain error is the deviation of the difference between the actual level of the last transition and the actual level of the first transition from the difference between the ideal levels. Gain error is expressed as a percentage as follows:

$$\begin{aligned} \text{Gain Error (\%)} &= 100 \times \frac{((PFS - NFS)_{ACTUAL\_CODE} - (PFS - NFS)_{IDEAL\_CODE})}{((PFS - NFS)_{IDEAL\_CODE})} \end{aligned} \quad (4)$$

where:

$PFS$  is positive full scale.

$NFS$  is negative full scale.

### Gain Error Drift

The gain error drift is the ratio of the gain error change due to a temperature change of  $1^{\circ}\text{C}$  and the full-scale range. Gain error drift is expressed in parts per million per degree Celsius (ppm/ $^{\circ}\text{C}$ ) as follows:

$$\text{Gain Error Drift (ppm}/^{\circ}\text{C}) = 10^6 \times \frac{(\text{Gain Error}_{T_{MAX}} - \text{Gain Error}_{T_{MIN}})}{(T_{MAX} - T_{MIN})} \quad (5)$$

where:

$$T_{MAX} = 105^{\circ}\text{C}.$$

$$T_{MIN} = -40^{\circ}\text{C}.$$

### Temperature Coefficient (TCV<sub>OUT</sub>)

The temperature coefficient relates the change in the output voltage to the change in the ambient temperature of the device, as normalized by the output voltage at  $25^{\circ}\text{C}$ . This parameter is specified using box method.

$$\text{TCV}_{OUT} = \left[ \frac{\max\{V_{OUT}(T_1, T_2, T_3)\} - \min\{V_{OUT}(T_1, T_2, T_3)\}}{V_{OUT}(T_2) \times (T_3 - T_1)} \right] \times 10^6 \quad (6)$$

where:

$\text{TCV}_{OUT}$  is expressed in ppm/ $^{\circ}\text{C}$ .

$V_{OUT}(T_X)$  is the output voltage at temperature  $T_X$ .

$$T_1 = -40^{\circ}\text{C}.$$

$$T_2 = +25^{\circ}\text{C}.$$

$$T_3 = +105^{\circ}\text{C}.$$

## TERMINOLOGY

### Long-Term Drift ( $\Delta V_{OUT\_LTD}$ )

Long-term drift refers to the shift in the output voltage vs. time. This is expressed as a difference in ppm from the nominal output.

$$\Delta V_{OUT\_LTD} = \left[ \frac{V_{OUT}(t_1) - V_{OUT}(t_0)}{V_{OUT}(t_0)} \right] \times 10^6 \quad (7)$$

where:

$\Delta V_{OUT\_LTD}$  is expressed in ppm.

$V_{OUT}(t_0)$  is the output voltage at the starting time of the measurement.

$V_{OUT}(t_1)$  is the output voltage at the end time of the measurement.

### Thermal Hysteresis ( $\Delta V_{OUT\_HYS}$ )

Thermal hysteresis represents the change in the output voltage after the device is exposed to a specified temperature cycle. This is expressed as a difference in ppm from the nominal output.

$$\Delta V_{OUT\_HYS} = \left[ \frac{V_{OUT1\_25^\circ C} - V_{OUT2\_25^\circ C}}{V_{OUT1\_25^\circ C}} \right] \times 10^6 \quad (8)$$

where:

$\Delta V_{OUT\_HYS}$  is expressed in ppm.

$V_{OUT1\_25^\circ C}$  is the output voltage at 25°C.

$V_{OUT2\_25^\circ C}$  is the output voltage after temperature cycling.

### Signal-to-Noise Ratio (SNR)

SNR is the ratio of the rms value of the actual input signal to the rms sum of all other spectral components below the Nyquist frequency, excluding harmonics and DC. The value for SNR is expressed in decibels.

### Total Harmonic Distortion (THD)

THD is the ratio of the rms sum of the first five harmonic components to the rms value of a full-scale input signal and is expressed in decibels.

### Signal-to-Noise-and-Distortion (SINAD) Ratio

SINAD is the ratio of the rms value of the actual input signal to the rms sum of all other spectral components that are less than the Nyquist frequency, including harmonics but excluding DC. The value for SINAD is expressed in decibels.

### Effective Number of Bits (ENOB)

ENOB is a measurement of the resolution with a sine wave input.

ENOB is related to SINAD as follows:

$$ENOB = \frac{SINAD_{dB} - 1.76}{6.02} \quad (9)$$

where  $ENOB$  is expressed in bits.

### Spurious-Free Dynamic Range (SFDR)

SFDR is the difference, in decibels (dB), between the rms amplitude of the input signal and the peak spurious signal.

### Common-Mode Rejection Ratio (CMRR)

CMRR is the ratio of the power in  $\mu$ Module output at the frequency,  $f$ , to the power of a 100 mV p-p sine wave applied to the input common-mode voltage of frequency,  $f$ .

$$CMRR(dB) = 10\log(P_{\mu Module\_IN}/P_{\mu Module\_OUT}) \quad (10)$$

where:

$P_{\mu Module\_IN}$  is the common-mode power at the frequency,  $f$ , applied to the inputs.

$P_{\mu Module\_OUT}$  is the power at the frequency,  $f$ , in the  $\mu$ Module output.

### Power-Supply Rejection Ratio (PSRR)

PSRR is the ratio of the power in the  $\mu$ Module output at the frequency,  $f$ , to the power of a 500 mV p-p sine wave applied to the VS+, REFIN, and IN\_LDO supply voltage centered at 5 V of frequency,  $f$ .

$$PSRR(dB) = 10\log(P_{\mu Module\_IN}/P_{\mu Module\_OUT}) \quad (11)$$

where:

$P_{\mu Module\_IN}$  is the power at the frequency,  $f$ , at the VS+, REFIN, and IN\_LDO pins.

$P_{\mu Module\_OUT}$  is the power at the frequency,  $f$ , at the  $\mu$ Module output.

### Aperture Delay

Aperture delay is the measure of the acquisition performance and is the time between the falling edge of the input and when the input signal is held for a conversion.

### Aperture Jitter

Aperture jitter is the variation in aperture delay.

## THEORY OF OPERATION

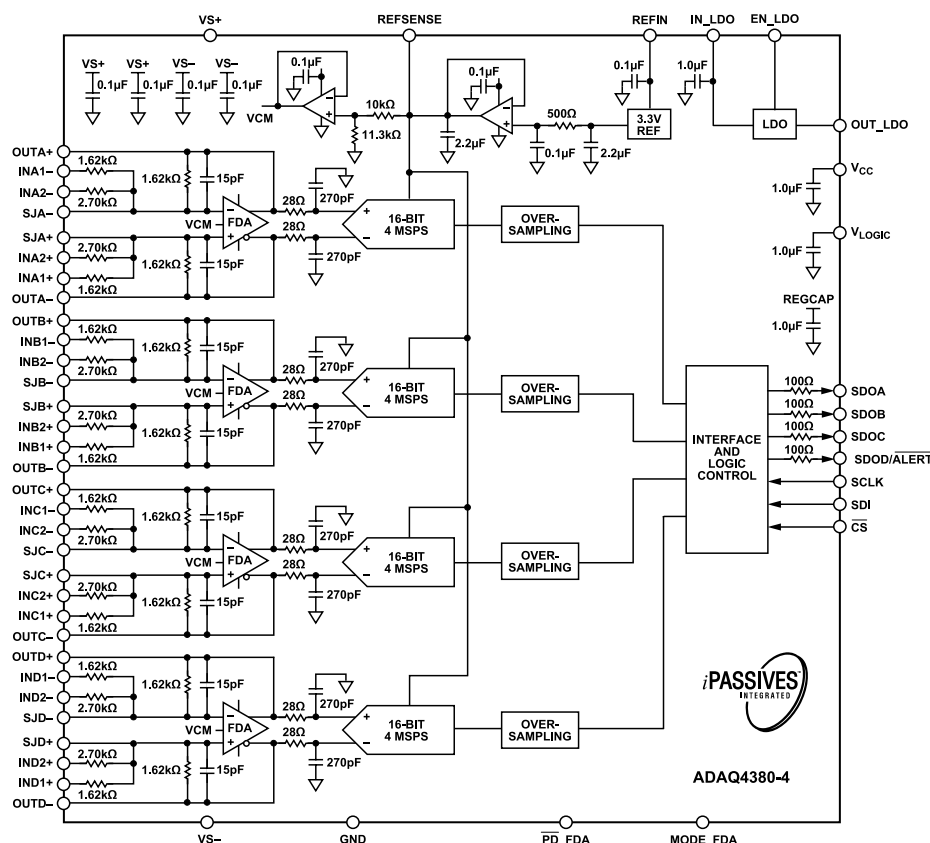


Figure 46. ADAQ4380-4 μModule Simplified Block Diagram

## CIRCUIT INFORMATION

The ADAQ4380-4 μModule SIP is a quad, high speed, and DAQ signal chain that uses a simultaneous sampling SAR architecture. As shown in Figure 46, the ADAQ4380-4 μModule DAQ system consists of a quad 16-bit SAR ADC, wide bandwidth, fully differential ADC driver, a precision low noise 3.3 V reference, low noise and stable reference buffers, and a 3.4 V LDO, along with critical precision passive components required to achieve optimal performance with pin selectable gain options of 0.3, 0.6, 1.0, and 1.6. All active components in the circuit, including iPassives® thin film resistors with  $\pm 0.005\%$  matching, are designed by Analog Devices, and are factory calibrated to achieve a high degree of specified accuracy and minimize temperature dependent error sources.

The ADAQ4380-4 simultaneously converts all the channels with a high throughput rate of 4 MSPS. The ADAQ4380-4 has integrated on-chip oversampling blocks to further improve the dynamic range and reduce noise at lower bandwidths. For more details, see the [ADC Modes of Operation](#) section. All the decoupling capacitors required by the ADC's voltage pins are all included inside the BGA package. Any external capacitors are not necessary.

THEORY OF OPERATION

TRANSFER FUNCTION

The ADAQ4380-4 uses an internal 3.3 V reference. The ADAQ4380-4 converts the differential voltage of the analog inputs (IN<sub>X</sub><sup>+</sup> and IN<sub>X</sub><sup>-</sup>) into a digital output.

The conversion result is MSB first, twos complement. The LSB size is  $(2 \times V_{REF})/2^N$ , where N is the ADC resolution. The ADC resolution is determined by the resolution of the device chosen, and if resolution boost mode is enabled. Table 8 outlines the LSB size expressed in volts for different resolutions.

The ideal transfer characteristic of the ADAQ4380-4 is shown in Figure 47.

Table 8. LSB Size

| Resolution | 3.3 V Reference | Unit |
|------------|-----------------|------|
| 16-bit     | 100.7           | μV   |
| 18-bit     | 25.2            | μV   |

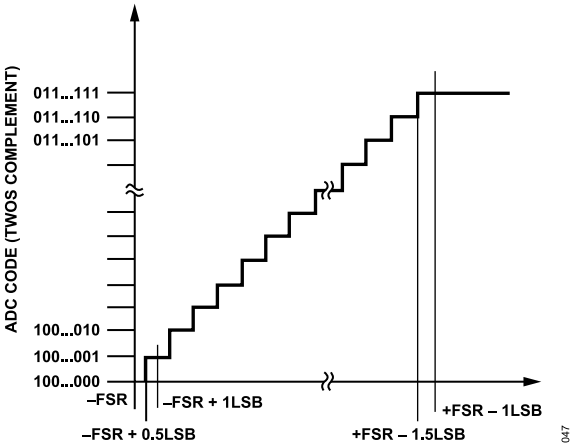


Figure 47. ADC Ideal Transfer Function (Full-Scale Range (FSR))

APPLICATIONS INFORMATION

TYPICAL CONNECTION DIAGRAMS

Figure 48 to Figure 55 show the typical connections diagram for each channel of the ADAQ4380-4 when applying differential, or single-ended input signals on four gain settings/combinations with varying common-mode voltage.

The four differential channels of the ADAQ4380-4 can accept wide input-voltage range and has a wide common-mode range that allows to convert a variety of signals. Differential and common-mode voltage ranges are highly dependent with the gain configuration per channel.

Table 9. Gain Configurations and Input Range

| Gain | Input Range         | Input Signal on Pins       | Test Conditions  |
|------|---------------------|----------------------------|--|
| 0.3  | $\pm 11\text{ V}$   | IN2+, IN2-                 | Connect IN1+ to OUT-, and IN1- to OUT+. See Figure 48 and Figure 52.                               |
| 0.6  | $\pm 5.5\text{ V}$  | IN2+, IN2-                 | Connect IN1+, IN1-. Leave OUT+ and OUT- floating. See Figure 49 and Figure 53.                     |
| 1.0  | $\pm 3.3\text{ V}$  | IN1+, IN1-                 | Leave IN2+, IN2-. OUT+ and OUT- floating. See Figure 50 and Figure 54.                             |
| 1.6  | $\pm 2.06\text{ V}$ | IN1+ or IN2+, IN1- or IN2- | Connect IN1+ to IN2+, and IN1- to IN2-. Leave OUT+ and OUT- floating. See Figure 51 and Figure 55. |

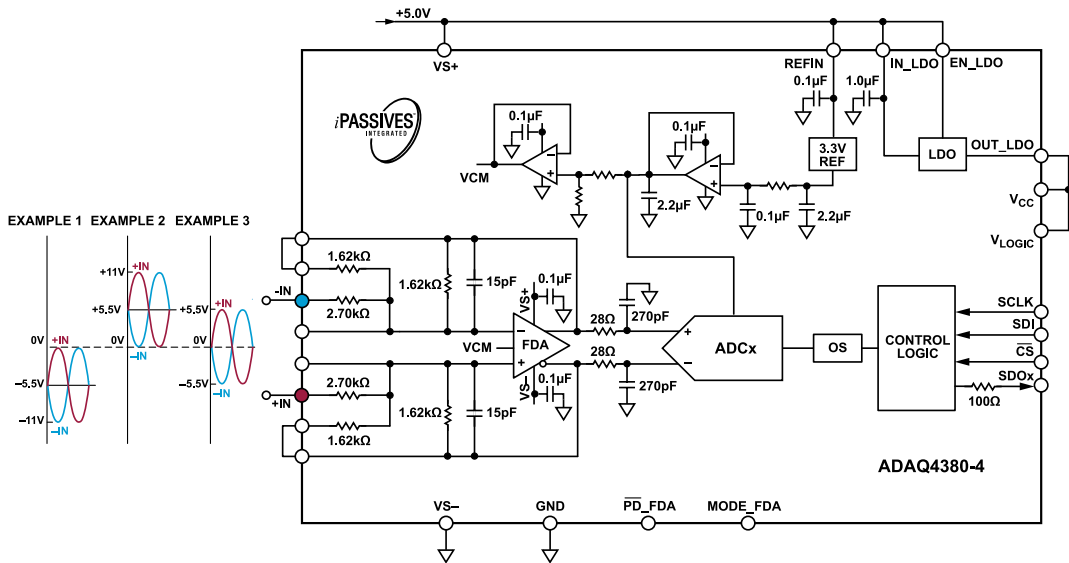


Figure 48. Fully Differential Input Configuration with Gain = 0.3,  $\pm 11\text{ V}$  Input,  $V_S = 5\text{ V}$

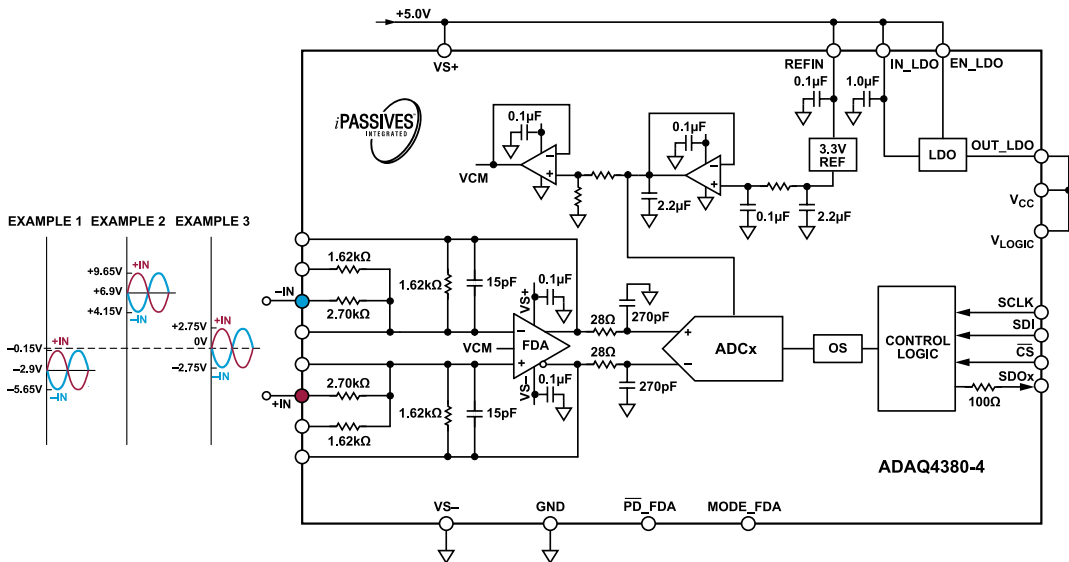
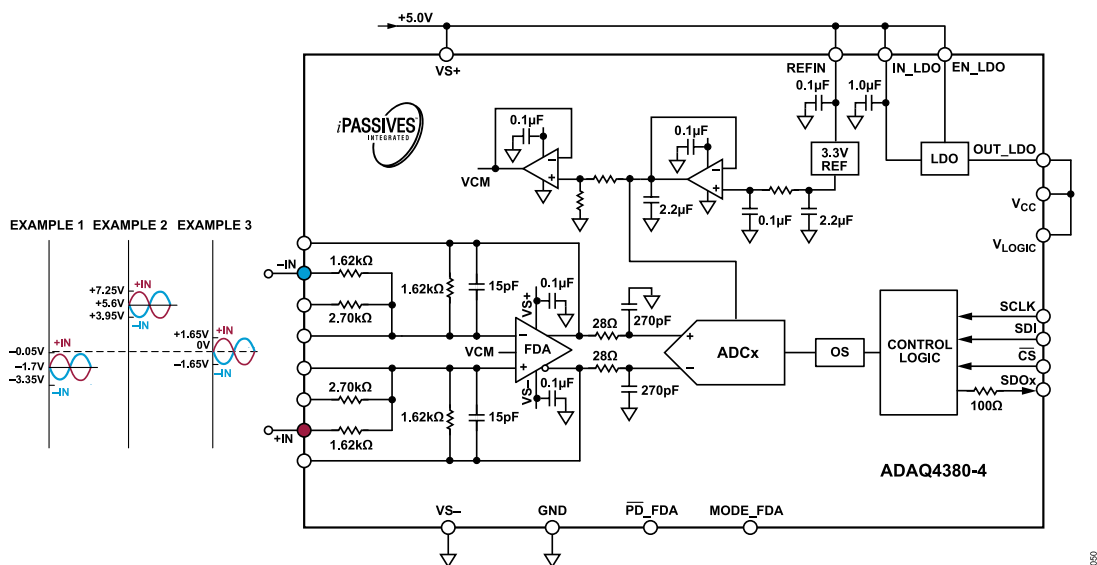
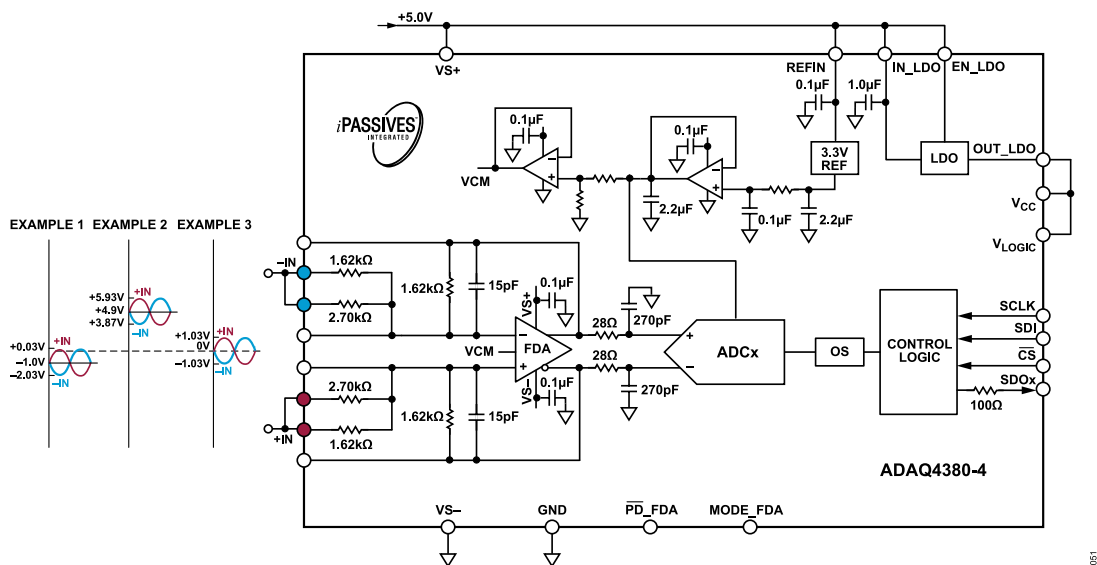


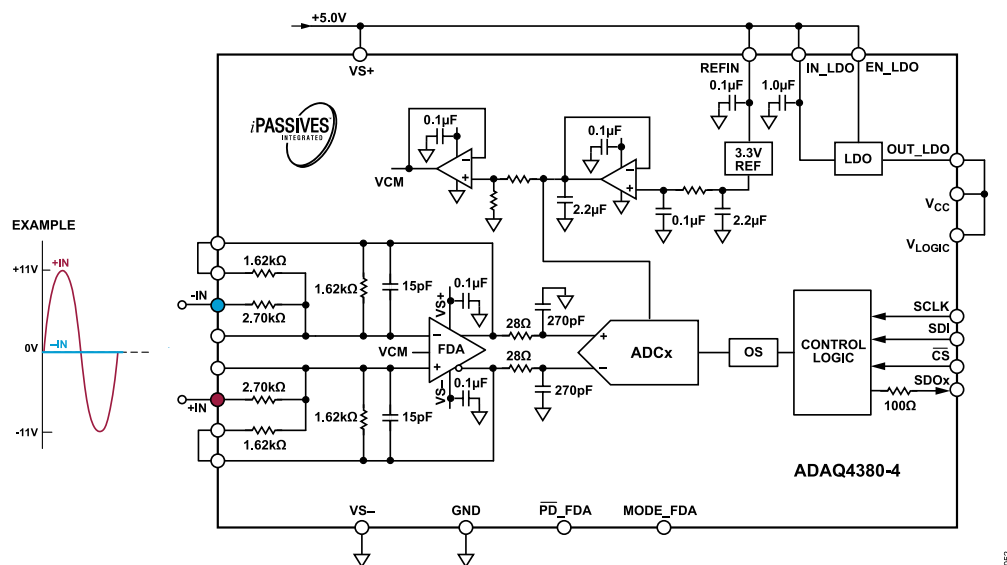
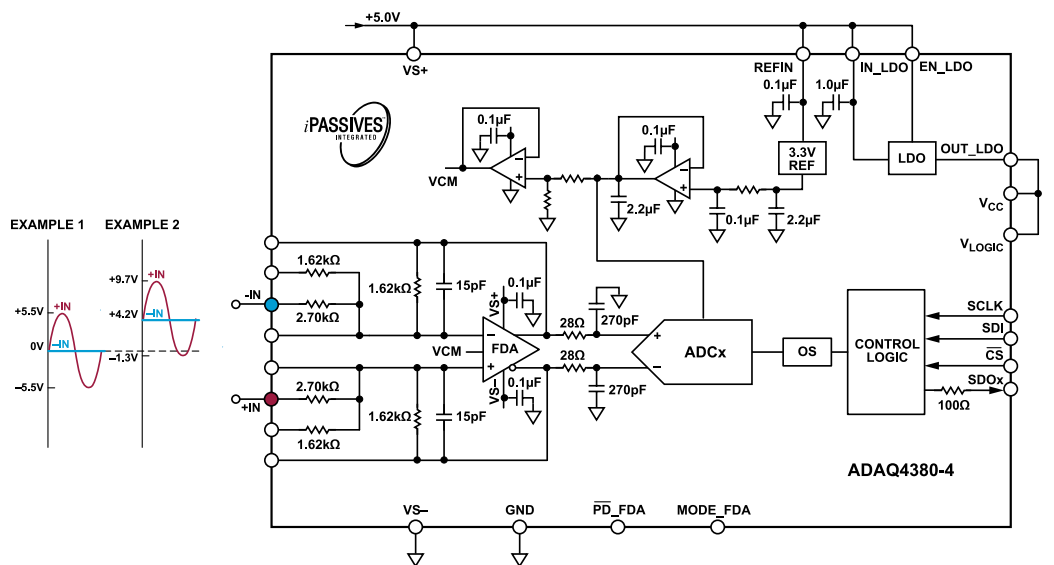
Figure 49. Fully Differential Input Configuration with Gain = 0.6,  $\pm 5.5\text{ V}$  Input,  $V_S = 5\text{ V}$



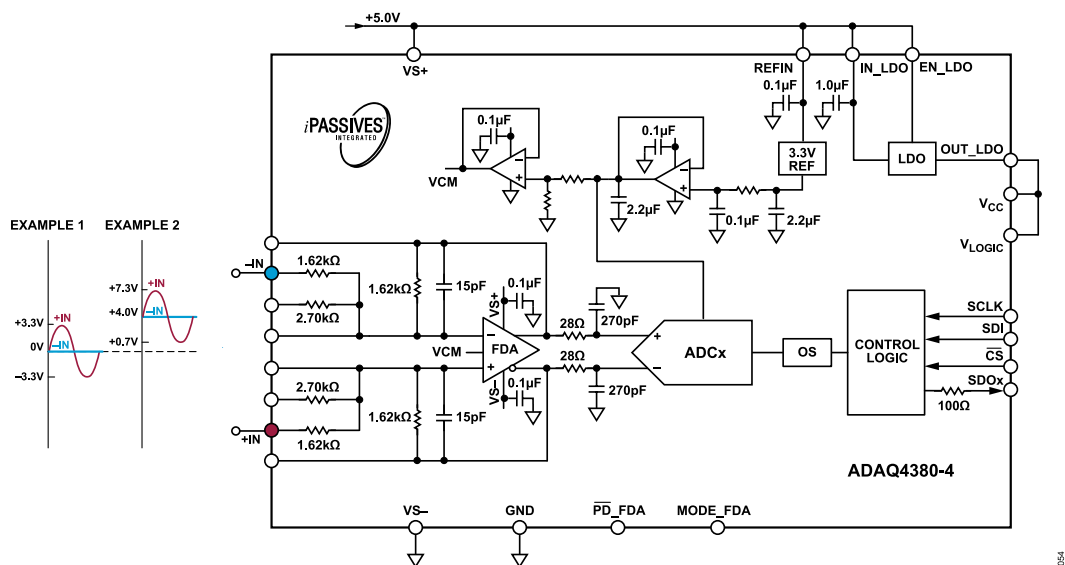
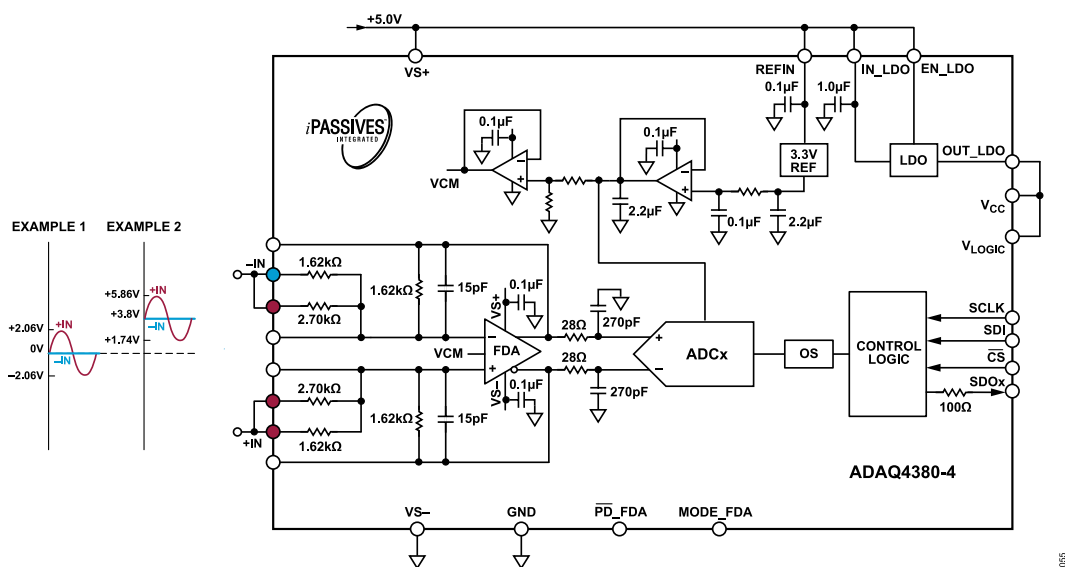
## APPLICATIONS INFORMATION

Figure 50. Fully Differential Input Configuration with Gain = 1.0,  $\pm 3.3\text{ V}$  Input,  $V_S = 5\text{ V}$ Figure 51. Fully Differential Input Configuration with Gain = 1.6,  $\pm 2.06\text{ V}$  Input,  $V_S = 5\text{ V}$

## APPLICATIONS INFORMATION

Figure 52. Single-Ended Input Configuration with Gain = 0.3,  $\pm 11$  V Input,  $V_S = 5$  VFigure 53. Single-Ended Input Configuration with Gain = 0.6,  $\pm 5.5$  V Input,  $V_S = 5$  V

## APPLICATIONS INFORMATION

Figure 54. Single-Ended Input Configuration with Gain = 1.0,  $\pm 3.3$  V Input,  $V_S = 5$  VFigure 55. Single-Ended Input Configuration with Gain = 1.6,  $\pm 2.06$  V Input,  $V_S = 5$  V

## APPLICATIONS INFORMATION

## ADC DRIVER

Integrated in the ADAQ4380-4  $\mu$ Module are four low noise, fully differential amplifiers as ADC drivers and their respective gain network passives. These ADC drivers have two power modes, full power and low-power mode. In full power mode, the ADAQ4380-4 is at optimum performance with slightly higher power consumption. In low-power mode, the ADAQ4380-4 consumes 20% less power but with a lower SNR ( $\sim 0.6$  dB at  $G = 1$ ).

## Input Common-Mode Voltage

The input common-mode voltage range (ICMVR) of the ADAQ4380-4 is highly dependent on the gain of the ADC drivers. Gain setting and gain options are detailed in Table 9. Each gain has different ICMVR to cater a wide range of input voltage at the front-end. Aside from the absolute differential input voltage, a user must consider input common-mode voltage for proper operation. Figure 56 and Figure 57 show the ICMVR of the ADAQ4380-4 for  $G = 0.3$  and  $G = 1$ , respectively.

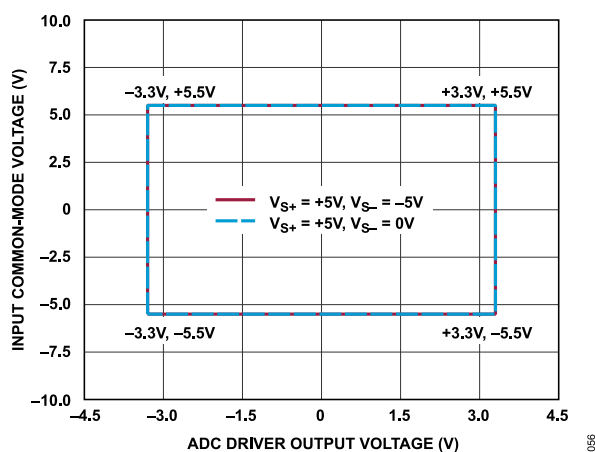


Figure 56. Input Common-Mode Voltage vs. ADC Driver Output, Gain = 0.3,  $\pm 11$  V Differential Input

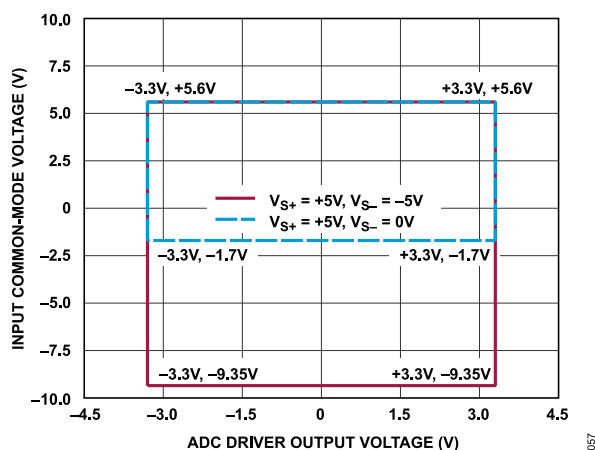


Figure 57. Input Common-Mode Voltage vs. ADC Driver Output, Gain = 1.0,  $\pm 3.3$  V Differential Input

## Calculating the Input Impedance of the Application Circuit

The effective input impedance depends on whether the signal source is single-ended or differential. For a balanced differential input signal, as shown in Figure 58, the input impedance ( $R_{IN,dm}$ ) between the inputs ( $IN+$  and  $IN-$ ) is:

$$R_{IN,dm} = 2 \times R_G \quad (12)$$

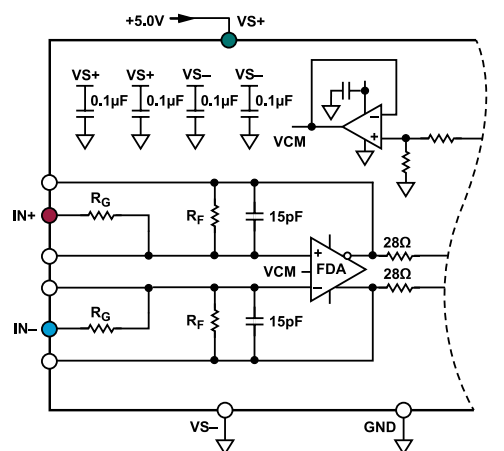


Figure 58. ADAQ4380-4 Configured at Fully Differential Inputs

For a single-ended input signal, as shown in Figure 59, the input impedance is:

$$R_{IN,SE} = \frac{R_G}{1 - \frac{R_F}{2(R_G + R_F)}} \quad (13)$$

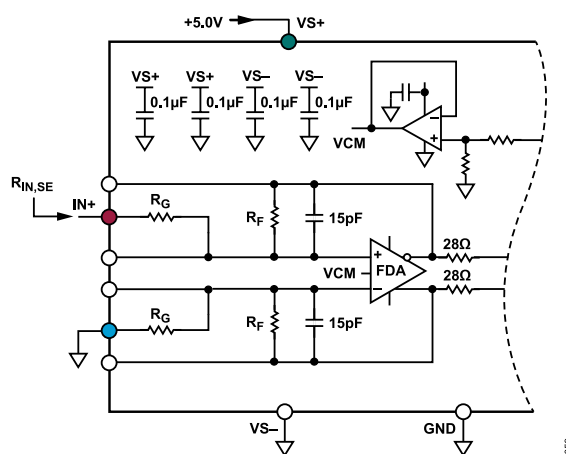


Figure 59. ADAQ4380-4 Configured at Single-Ended Inputs

The input impedance of the circuit is effectively higher than it is for a conventional operational amplifier (op amp) connected as an inverter because a fraction of the differential output voltage appears at the inputs as a common-mode signal, partially bootstrapping the voltage across the  $R_G$  input resistor.

## APPLICATIONS INFORMATION

## Terminating a Single-Ended Input

When the circuitry driving the inputs has a very-low output impedance, there is no need for an additional termination on the IN+ and IN- inputs of the ADAQ4380-4. However, when there is a considerable amount of resistance from the driving circuitry, Analog Devices recommend that a balancing network must be added on the inputs of the ADAQ4380-4. For techniques on how to properly terminate the inputs for a single-ended input operation, refer to the [Application Note 1026: High Speed Differential ADC Driver Design Considerations](#).

## INTERNAL REFERENCE

The ADAQ4380-4  $\mu$ Module has an internal precision voltage reference that offers high accuracy, low noise, and low drift (3 ppm/ $^{\circ}$ C typical). Connect REFIN to a clean 5 V supply to ensure optimum performance. Bypass and load capacitors for stability are already included inside the  $\mu$ Module package, therefore external capacitors are not necessary. The 3.3 V output of this reference is utilized as the ADC reference, and VCM for ADC drivers.

REFSENSE pin is part of the internal reference circuitry. It is connected directly to the ADC reference input and reference buffer's output. Using the REFSENSE pin as a reference or a voltage source for another part of the system is not recommended, and may degrade the ADAQ4380-4 performance. Use this pin for accurate gain calibration only, otherwise do not connect.

The initial voltage accuracy of the internal reference at ambient temperature is shown in [Figure 60](#). A sample of 100 units shows the REFSENSE output voltage is centered at 3.3 V with a mean value of 3.3004 V.

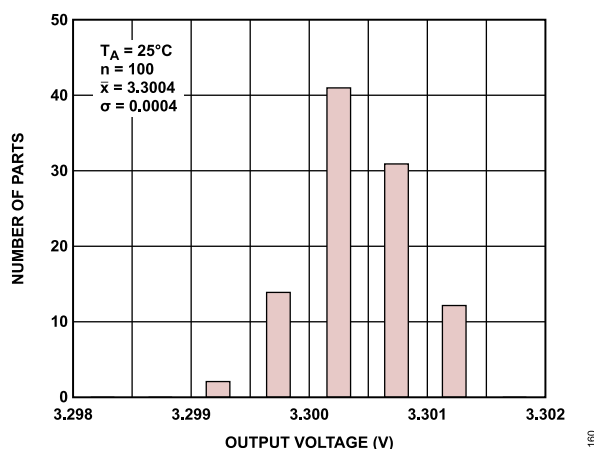


Figure 60. ADAQ4380-4 Internal Reference Output Voltage Accuracy

## Long-Term Drift

To determine the long-term drift of the ADAQ4380-4 internal reference, the change in output voltage of multiple units are measured for more than 1000 hours. The drift data is taken on 19 parts that are soldered onto FR4 PCB using a standard reflow profile to repli-

cate real-world system applications. The boards are then soaked in an ultrastable oil bath with a controlled constant temperature of 25 $^{\circ}$ C, the outputs are scanned regularly and measured using a high precision measurement system.

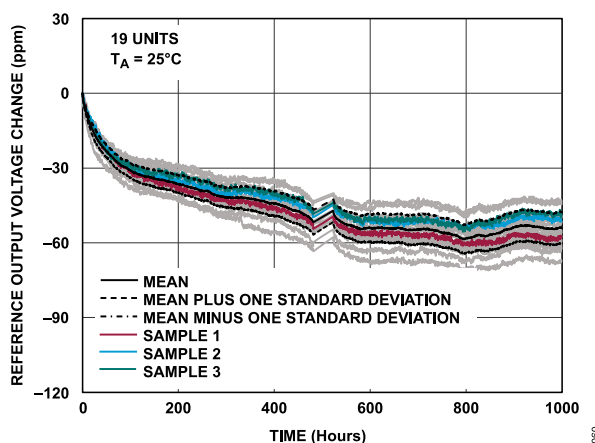


Figure 61. ADAQ4380-4 Internal Reference Long-Term Drift

[Figure 61](#) shows the long-term drift of the ADAQ4380-4 internal 3.3 V reference, output voltage drift of 54 ppm after 800 hours. Drastic shift on the output voltage is observed from 0 hours to 250 hours, as shown in [Figure 62](#). With a mean drift of 39 ppm, early life drift account for 72% of the total drift observed within 1000 hours.

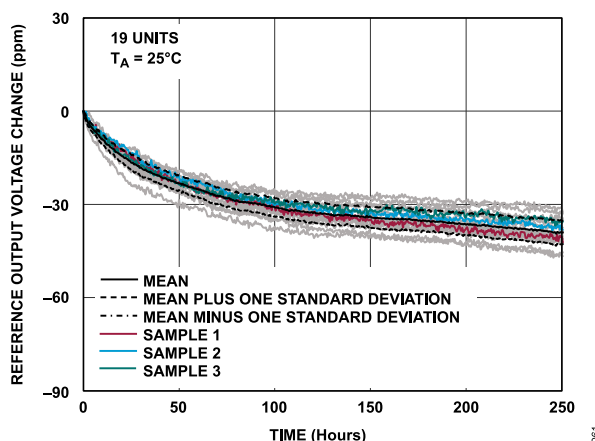


Figure 62. ADAQ4380-4 Internal Reference Early Life Drift

## Thermal Hysteresis

In addition to stability over time, as described in the [Long-Term Drift](#) section, it is useful to know the thermal hysteresis, that is, the stability vs. cycling of temperature. Thermal hysteresis tells how closely the signal returns to its starting amplitude after the ambient temperature changes and the subsequent return to room temperature.

## APPLICATIONS INFORMATION

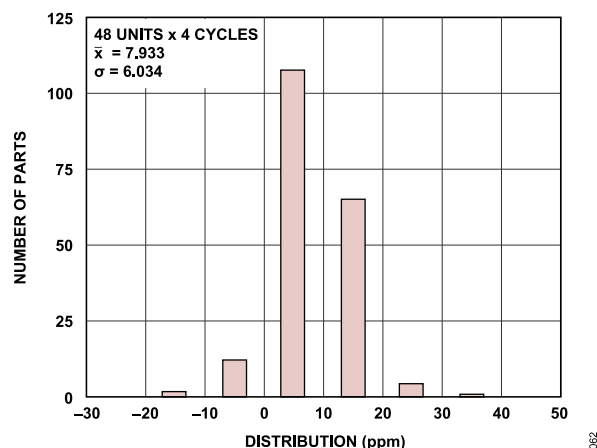


Figure 63. Reference Output Voltage Hysteresis at Four Full Cycles

Figure 63 shows the hysteresis when the part is subjected to a full temperature cycles four times from room temperature to  $-40^{\circ}\text{C}$  to  $+105^{\circ}\text{C}$  and back to room temperature. In four full cycles, the output hysteresis is typically 8 ppm. The histogram in Figure 64 shows that the hysteresis is larger when the device cycles through only a half cycle, from room temperature to  $105^{\circ}\text{C}$  and back to room temperature, typically  $\sim 50$  ppm, and from room temperature to  $-40^{\circ}\text{C}$  and back to room temperature, typically 43 ppm.

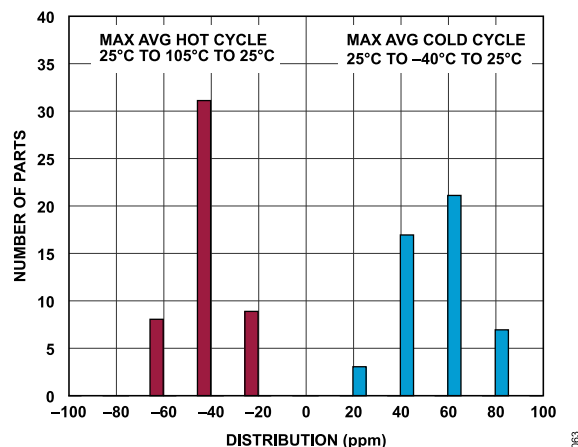


Figure 64. Reference Output Voltage Hysteresis at Half Cycles

## INTERNAL LDO

The ADAQ4380-4  $\mu$ Module has an internal LDO regulator. To use this, connect IN\_LDO and EN\_LDO to 5 V. Input bypass capacitors are already integrated within the  $\mu$ Module, external bypass capacitors are not necessary. The output of this LDO is intended to power the ADC VCC and VLOGIC supply rails. During normal operation, connect VCC and VLOGIC directly to OUT\_LDO, no need for external capacitors. If applications require external supplies for VCC and VLOGIC, disable the internal LDO by connecting EN\_LDO to GND.

## POWER SUPPLY AND DECOUPLING

The ADAQ4380-4 has six independent power supplies, VS+, VS-, REFIN, IN\_LDO, VCC, and VLOGIC that supply the analog circuitry and digital interface, respectively. For the detailed description of each supply pins, see Table 7. The ADAQ4380-4 is guaranteed to achieve its optimum performance at single, 5 V supply operation. Decoupling these supply pins may not be necessary since decoupling capacitors are already integrated in the ADAQ4380-4 internal circuitry. Additionally, the ADAQ4380-4 features an internal reference and reference buffer decoupled to ground. There is no need to add external decoupling caps on the REFSense pin.

Figure 65 shows the recommended power companion products for the ADAQ4380-4. For more details, refer to the ADAQ4380-4 LTPower Planner in the product website.

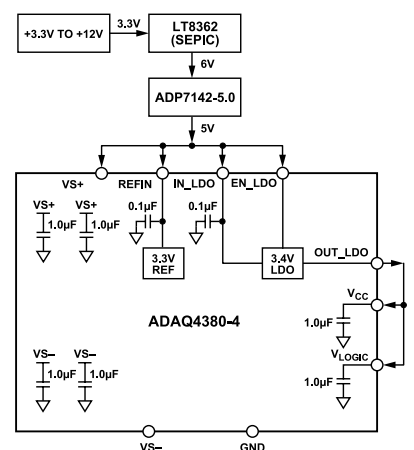


Figure 65. ADAQ4380-4 Power Supply Recommendations

## Power-Up

Care must be taken to adhere to the maximum voltage relationships described in the Absolute Maximum Ratings section. The ADAQ4380-4 is not easily damaged by power supply sequence, Figure 65 shows the recommended power supply utilizing the internal LDO to power up VCC and VLOGIC. Although the ADAQ4380-4 is robust to power supply sequencing, if applications require an external VCC and VLOGIC, the best sequence is to power VCC and VLOGIC first, followed by VS+ and VS- and lastly with REFIN. Between VCC and VLOGIC, either can be powered up first. Analog and digital signals must be applied after the reference is applied.

The ADAQ4380-4 requires a  $t_{\text{POWER-UP}}$  time from applying VCC and VLOGIC until the ADC conversion results are stable. For the recommended signal condition during power-up, see Figure 4. It is recommended to pull the pin high during power-up and have a software reset after the power-up. Conversion results are not guaranteed to meet data sheet specifications during this time and must be ignored.

## ADC MODES OF OPERATION

The ADAQ4380-4 has several on-chip configuration registers for controlling the operational mode of the device.

### OVERSAMPLING

Oversampling is a common method used in signal processing to improve the accuracy of the ADC result. Multiple samples of the analog input are captured and averaged to reduce the noise component from quantization noise and thermal noise (kTC) of the ADC. The ADAQ4380-4 offers an on-chip oversampling function and has two user configurable oversampling modes: normal averaging and rolling averaging.

The oversampling functionality is configured by programming the OS\_MODE bit and OSR bits in the [Configuration1 Register](#).

### Normal Average Oversampling

Normal average oversampling mode can be used in applications where slower output data rates are needed and where higher SNR or dynamic range is desired. Normal averaging involves taking a number of samples, adding them together and dividing the result by the number of samples taken. This result is then output from the device. The sample data is cleared after the process is completed.

Normal average oversampling mode is configured by setting the OS\_MODE bit to Logic 0 and having a valid nonzero value in the OSR bits. The oversampling ratio of the digital filter is controlled using the oversampling bits, OSR.

[Table 10](#) provides the oversampling bit decoding to select the different oversample rates. The output result is decimated to 16-bit resolution. If additional resolution is required, this can be achieved by configuring the resolution boost bit (RES) in the [Configuration1 Register](#). For more details, see the [Resolution Boost](#) section.

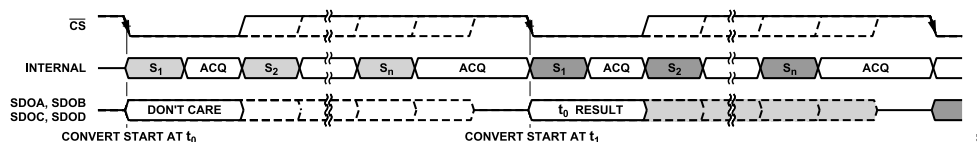
The number of samples (n), defined by the OSR bits, is taken and added together, and the result is divided by n. The initial ADC conversion is initiated by the falling edge of  $\overline{CS}$ , and the ADAQ4380-4 controls all subsequent samples in the oversampling sequence internally. The sampling rate of the additional n samples at the device's maximum sampling rate is 4 MSPS. The data is ready for readback on the next serial interface access. After the averaging technique is applied, the sample data used in the calculation is discarded. This process is repeated every time the application needs a new conversion result and initiates by the falling edge of  $\overline{CS}$ .

As the output data rate is reduced by the oversampling ratio, the SPI frequency required to transmit the data is also reduced accordingly.

**Table 10. Normal Average Oversampling Overview, G = 1**

| OSR [2:0] | OS Ratio | SNR (dB typical) with $V_{REF} = 3.3\text{ V}$ Internal |                  | Data Output Rate (kSPS max) |
|-----------|----------|---|------------------|-----------------------------|
|           |          | RES = 0   | RES = 1          |                             |
| 000       | No OS    | 91.1  | 91.1             | 4000                        |
| 001       | 2        | 92.6  | 93.8             | 1000                        |
| 010       | 4        | 94  | 96.2             | 500                         |
| 011       | 8        | 95  | 98.1             | 250                         |
| 100       | 16       | 95.5  | 99.4             | 125                         |
| 101       | 32       | 95.6  | 99.6             | 62.5                        |
| 110       | Invalid  | N/A <sup>1</sup>  | N/A <sup>1</sup> | N/A <sup>1</sup>            |
| 111       | Invalid  | N/A <sup>1</sup>  | N/A <sup>1</sup> | N/A <sup>1</sup>            |

<sup>1</sup> N/A means not applicable.



**Figure 66. Normal Average Oversampling Operation**



ADC MODES OF OPERATION

Rolling Average Oversampling

Rolling average oversampling mode can be used in applications where higher output data rates are required and where a higher SNR or dynamic range is desired. Rolling averaging involves taking a number of samples, adding them together, and dividing the result by the number of samples taken. This result is then output from the device. The sample data is not cleared when the process completes. The rolling oversampling mode uses a first in, first out (FIFO) buffer of the most recent samples in the averaging calculation, which allows the ADC throughput rate and output data rate to stay the same.

Rolling average oversampling mode is configured by setting the OS\_MODE bit to Logic 1 and having a valid nonzero value in the OSR bits. The oversampling ratio of the digital filter is controlled using the oversampling bits, OSR (see Table 11).

Table 11 provides the oversampling bit decoding to select the different oversample rates. The output result is decimated to 16-bit

resolution for the ADAQ4380-4. If additional resolution is required, then this can be achieved by configuring the resolution boost bit in the Configuration1 Register. For more details, see the Resolution Boost section.

In rolling average oversampling mode, all ADC conversions are controlled and initiated by the falling edge of  $\overline{CS}$ . When a conversion is complete, the result is loaded into the FIFO. The FIFO length is 8 regardless of the oversampling ratio set. The FIFO is filled on the first conversion after a power-on-reset (POR), on the first conversion after a software controlled hard or soft reset. A new conversion result is shifted into the FIFO on completion of every ADC conversion regardless of the status of the OSR bits and the OS\_MODE bit. This conversion allows a seamless transition from no oversampling to rolling average oversampling, or different rolling average oversampling ratios without waiting for the FIFO to fill.

The number of samples,  $n$ , defined by the OSR bits are taken from the FIFO, added together and the result is divided by  $n$ .

Table 11. Rolling Average Oversampling Overview, G = 1

| OSR [2:0] | OS Ratio | SNR (dB typical) |                  | Data Output Rate (kSPS max) |
|-----------|----------|------------------|------------------|-----------------------------|
|           |          | RES = 0          | RES = 1          |                             |
| 000       | No OS    | 91.1             | 91.1             | 4000                        |
| 001       | 2        | 92.1             | 93.1             | 4000                        |
| 010       | 4        | 93.7             | 95.9             | 4000                        |
| 011       | 8        | 95               | 98.3             | 4000                        |
| 110       | Invalid  | N/A <sup>1</sup> | N/A <sup>1</sup> | N/A <sup>1</sup>            |
| 111       | Invalid  | N/A <sup>1</sup> | N/A <sup>1</sup> | N/A <sup>1</sup>            |

<sup>1</sup> N/A means not applicable.

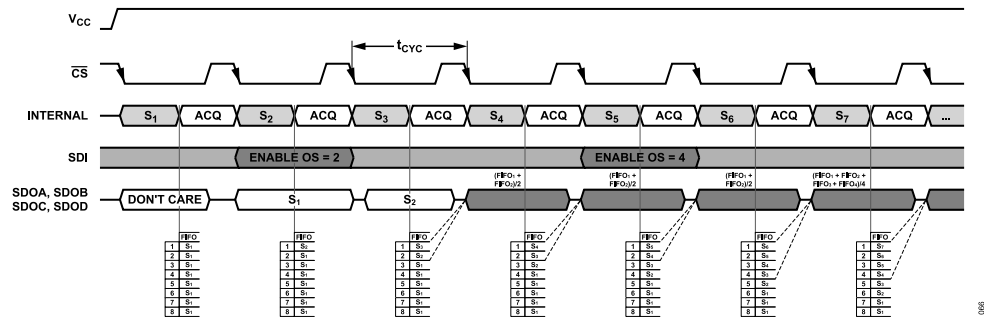


Figure 67. Rolling Average Oversampling Mode Operation



## ADC MODES OF OPERATION

### RESOLUTION BOOST

The default resolution and output data size for the ADAQ4380-4 is 16 bits. When the on-chip oversampling function is enabled the performance of the ADC can exceed the default resolution. To accommodate the performance boost achievable, it is possible to enable an additional two bits of resolution. If the RES bit in the [Configuration1 Register](#) is set to Logic 1 and the ADAQ4380-4 is in a valid oversampling mode, the conversion result size for the ADAQ4380-4 is 18 bits. In this mode, 18 SCLK cycles are required to propagate the data for the ADAQ4380-4, see [Figure 68](#).

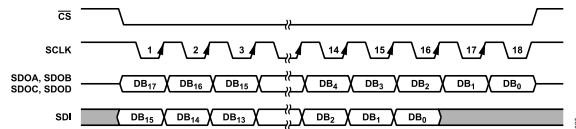


Figure 68. Resolution Boost

### ALERT

The alert functionality is an out-of-range indicator and can be used as an early indicator of an out of bounds conversion result. An alert event triggers when the value in the conversion result register exceeds the alert high limit value in the [Alert High Threshold Register](#) or falls below the alert low limit value in the [Alert Low Threshold Register](#). The [Alert High Threshold Register](#) and the [Alert Low Threshold Register](#) are common to all ADCs. When setting the threshold limits, the alert high threshold must always be greater than the alert low threshold. Detailed alert information is accessible in the [Alert Indication Register](#).

The register contains two status bits per ADC, one corresponding to the high limit, and the other to the low limit. A logical OR of alert signals for all ADCs creates a common alert value. This value can be configured to drive out on the  $\overline{\text{ALERT}}$  function of the SDO/ALERT pin. The SDO/ALERT pin is configured as  $\overline{\text{ALERT}}$  by configuring the following bits in the [Configuration1 Register](#) and the [Configuration2 Register](#):

- ▶ Set the SDO bits to any value other than 0b10.
- ▶ Set the ALERT\_EN bit to 1.
- ▶ Set a valid value in the alert high threshold register and the alert low threshold register.

The alert indication function is available in oversampling (rolling averaging, normal averaging, and in non-oversampling modes). The alert function of the SDO/ALERT pin updates at the end of conversion. The alert indication status bits in the  $\overline{\text{ALERT}}$  register are updated as well and must be read before the end of next conversion.

Bits [7:0] in the alert indication register are cleared by reading the alert register contents. The alert function of the SDO/ALERT pin is cleared with a falling edge of  $\overline{\text{CS}}$ . Issuing a software reset also clears the alert status in the alert indication register.

For the  $\overline{\text{ALERT}}$  timing diagram, see [Figure 8](#).

### POWER MODES

The ADAQ4380-4 has two power modes that can be set in the [Configuration1 Register](#): normal mode and shutdown mode. These modes of operation provide flexible power management options, which allow optimization of the power dissipation and throughput rate ratio for different application requirements.

Program the PMODE bit in the [Configuration1 Register](#) to configure the power modes in the ADAQ4380-4. Set PMODE to Logic 0 for normal mode and Logic 1 for shutdown mode.

#### Normal Mode

Keep the ADAQ4380-4 in normal mode to achieve the fastest throughput rate. All ADC blocks always remain fully powered and an ADC conversion can be initiated by a falling edge of CS when required. When the ADAQ4380-4 is not converting, it is in static mode and power consumption is automatically reduced. Additional current is required to perform a conversion. Therefore, power consumption of the ADAQ4380-4 scales with throughput.

#### Shutdown Mode

When slower throughput rates and lower power consumption are required, use shutdown mode by either powering down the ADC between each conversion or by performing a series of conversions at a high throughput rate and then powering down the ADC for a relatively long duration between these burst conversions. When the ADAQ4380-4 is in shutdown mode, all analog circuitry powers down. The serial interface remains active during shutdown mode to allow the ADAQ4380-4 to exit shutdown mode.

To enter shutdown mode, write to the power mode configuration bit, PMODE, in the [Configuration1 Register](#).

The ADAQ4380-4 shuts down and current consumption reduces. To exit shutdown mode and return to normal mode set the PMODE bit in the [Configuration1 Register](#) to Logic 0.

All register configuration settings remain unchanged entering or leaving shutdown mode. After exiting shutdown mode, sufficient time must be allowed for the circuitry to turn on before starting a conversion, see [Figure 69](#).

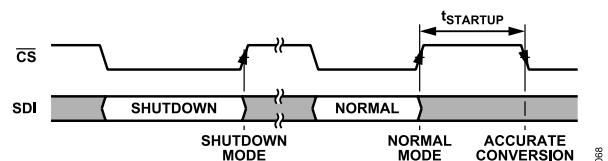


Figure 69. Shutdown Mode Operation

## ADC MODES OF OPERATION

### SOFTWARE RESET

The ADAQ4380-4 has two reset modes: a soft reset and a hard reset. A reset is initiated by writing to the reset bits in the [Configuration2 Register](#).

A soft reset maintains the contents of the configurable registers but refreshes the interface and the ADC blocks. Any internal state machines are reinitialized, and the oversampling block and FIFO are flushed. The register is cleared. The reference and LDO remain powered.

A hard reset, in addition to the blocks reset by a soft reset, resets all user registers to the default status, resets the reference buffer, and resets the internal oscillator block, see [Figure 70](#).

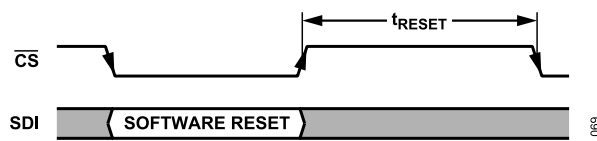


Figure 70. Software Reset Operation

### DIAGNOSTIC SELF TEST

The ADAQ4380-4 runs a diagnostic self test after a POR or after a software hard reset to ensure correct configuration is loaded into the device.

The result of the self test is displayed in the SETUP\_F bit in the [Alert Indication Register](#). If the SETUP\_F bit is set to Logic 1, the diagnostic self test has failed. If the test fails, perform a software hard reset to reset the ADAQ4380-4 registers to the default status.

INTERFACE

The interface to the ADAQ4380-4 is through a serial interface. The interface consists of a  $\overline{CS}$ , SCLK, SDOA, SDOB, SDOC, SDOD, and SDI. When referencing a single function of a multifunction pin, only the portion of the pin name that is relevant to the specification is listed, such as SDOD. For full pin names of multifunction pins, see the [Pin Configurations and Function Descriptions](#) section.

The  $\overline{CS}$  signal frames a serial data transfer and initiates an ADC conversion process. The falling edge of  $\overline{CS}$  puts the track-and-hold into hold mode, at which point the analog input is sampled and the bus is taken out of three-state. The ADC conversion operation is driven internally by an on-board oscillator and is independent of the SCLK signal.

The SCLK signal synchronizes data in and out of the device through the SDOA, SDOB, SDOC, SDOD, and SDI signals. A minimum of 16 SCLK cycles are required for a write to or read from a register. The minimum numbers of SCLK cycles for a conversion read is dependent on the resolution of the device and the configuration settings, see [Table 12](#).

The ADAQ4380-4 has four serial output signals: SDOA, SDOB, SDOC, and SDOD. Programming the SDO bits in the [Configuration2 Register](#) configures 2-wire, 1-wire, or 4-wire mode. To achieve the highest throughput of the device, it is required to use either the 2-wire or 4-wire mode to read conversion results. If a reduced throughput is required or oversampling is used, it is possible to use 1-wire mode, SDOA signal only, for reading conversion results.

Configuring cyclic redundancy check (CRC) operation for SPI reads, SPI writes and over sampling mode with resolution boost mode enabled will alter the operation of the interface. To ensure a correct operation, see the [CRC](#) section.

READING CONVERSION RESULTS

The  $\overline{CS}$  signal initiates the conversion process. A high-to-low transition on the signal initiates a simultaneous conversion of the four ADCs: ADC A, ADC B, ADC C, and ADC D. The ADAQ4380-4 has a one cycle readback latency. Therefore, the conversion results are available on the next SPI access. Then, take the  $\overline{CS}$  signal low, and the conversion result clocks out on the serial output pins. The next conversion is also initiated at this point.

The conversion result is shifted out of the device as a 16-bit result for the ADAQ4380-4. The MSB of the conversion result is shifted out on the  $\overline{CS}$  falling edge. The remaining data is shifted out of the device under the control of the serial clock (SCLK) input. The data is shifted out on the rising edge of SCLK, and the data bits are valid on both the falling edge and the rising edge. After the final SCLK falling edge, take  $\overline{CS}$  high again to return the serial data output pins to a high impedance state.

The number of SCLK cycles to propagate the conversion results on the SDO pins is dependent on the serial mode of operation configured and if resolution boost mode is enabled, for more details, see [Figure 71](#) and [Table 12](#). If CRC reading is enabled, an additional SCLK pulses are required to propagate the CRC information. For more details, see the [CRC](#) section.

Because the  $\overline{CS}$  signal initiates a conversion as well as framing the data, any data access must be completed within a single frame.

Table 12. Number of SCLK Cycles (n) Required for Reading Conversion Results

| Interface Configuration | Resolution Boost Mode | CRC Read | No. of SCLK Cycles |
|-------------------------|-----------------------|----------|--------------------|
| 4-Wire                  | Disabled              | Disabled | 16                 |
|                         |                       | Enabled  | 24                 |
|                         | Enabled               | Disabled | 18                 |
|                         |                       | Enabled  | 26                 |
| 2-Wire                  | Disabled              | Disabled | 32                 |
|                         |                       | Enabled  | 40                 |
|                         | Enabled               | Disabled | 36                 |
|                         |                       | Enabled  | 44                 |
| 1-Wire                  | Disabled              | Disabled | 64                 |
|                         |                       | Enabled  | 72                 |
|                         | Enabled               | Disabled | 72                 |
|                         |                       | Enabled  | 80                 |

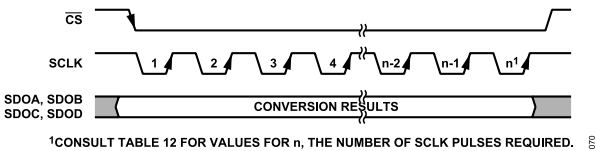


Figure 71. Reading Conversion Results

Serial 4-Wire Mode

Configure 4-wire mode by setting the SDO bits to 0b10 in the [Configuration2 Register](#). In 4-wire mode, the conversion results for ADC A is output on SDOA, ADC B on SDOB, ADC C on SDOC, and ADC D on SDOD.

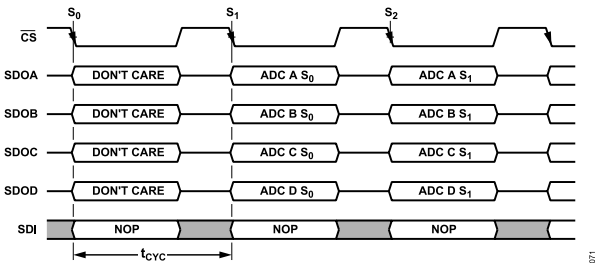


Figure 72. Read Conversion Results, 4-Wire Mode

## INTERFACE

## Serial 2-Wire Mode

Configure 2-wire mode by setting the SDO bits to 0b00 in the [Configuration2 Register](#). In 2-wire mode the conversion results for ADC A and ADC C are output on SDOA. The conversion result for ADC B and ADC D are output on SDOB.

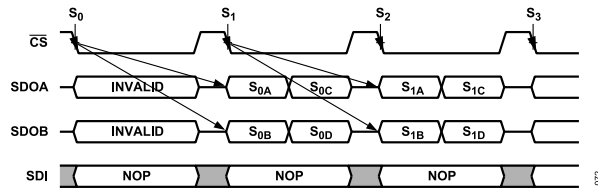


Figure 73. Reading Conversion Results, 2-Wire Mode

## Serial 1-Wire Mode

In applications where slower throughput rates are allowed or normal averaging oversampling is used, the serial interface can be configured to operate in 1-wire mode. In 1-wire mode the conversion results from ADC A, ADC B, ADC C, and ADC D are output on SDOA. Additional SCLK cycles are required to propagate all the data. ADC A data is output first followed by ADC B, ADC C, and ADC D conversion results.

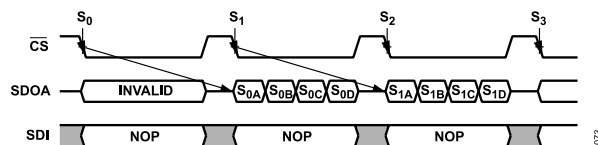


Figure 74. Read Conversion Results, 1-Wire Mode

## LOW LATENCY READBACK

The interface on the ADAQ4380-4 has a one cycle latency as shown in [Figure 72](#). For applications that operate at lower throughput rates, the latency of reading the conversion result can be reduced. After the conversion time,  $t_{\text{CONVERT}}$ , elapses, a second  $\overline{\text{CS}}$  pulse after the initial  $\overline{\text{CS}}$  pulse that initiated the conversion can be used to readback the conversion result. This operation is shown in [Figure 75](#).

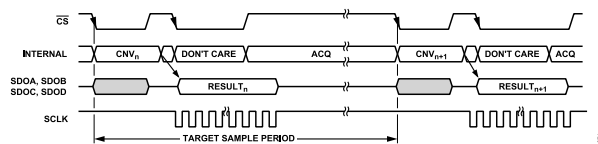


Figure 75. Low Throughput and Low Latency

## READING FROM DEVICE REGISTERS

All registers in the device can be read over the serial interface. A register read is performed by issuing a register read command followed by an additional SPI command that can be either a valid command or no operation command (NOP). The format for a read command is shown in [Table 15](#). Bit D15 must be set to 0 to select a read command. Bits[D14:D12] contain the register address. The subsequent 12 bits, Bits[D11:D0], are ignored.

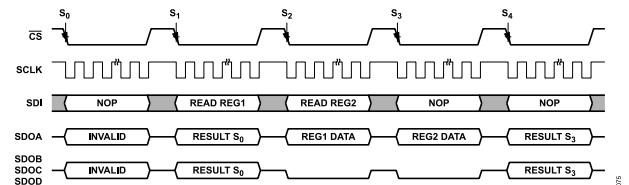


Figure 76. Register Read

## WRITING TO DEVICE REGISTERS

All the read/write registers in the ADAQ4380-4 can be written to over the serial interface. The length of a SPI write access is determined by the CRC write function. An SPI access is 16 bits if CRC write is disabled and 24-bit when CRC write is enabled. The format for a write command is shown in [Table 15](#). Bit D15 must be set to 1 to select a write command. Bits[D14:D12] contain the register address. The subsequent 12 bits, Bits[D11:D0], contain the data to be written to the selected register.

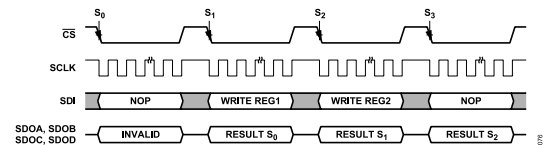


Figure 77. Register Write

## INTERFACE

### CRC

The ADAQ4380-4 has CRC checksum modes that can be used to improve interface robustness by detecting errors in data transmissions. The CRC feature is independently selectable for SPI interface reads and SPI interface writes. For example, enable the CRC function for SPI writes to prevent unexpected changes to the device configuration but not enable it on SPI reads to maintain a higher throughput rate. The CRC feature is controlled by programming the CRC\_W bit and CRC\_R bit in the [Configuration1 Register](#).

### CRC Read

If enabled, a CRC consisting of an 8-bit word is appended to the conversion result or register reads. The CRC is calculated on the conversion result for ADC A, ADC B, ADC C, and ADC D and output on SDOA. A CRC is also calculated and appended to register read outputs.

The CRC read function can be used in 1-wire SPI mode, 2-wire SPI mode, 4-wire SPI mode, and resolution boost mode.

### CRC Write

To enable the CRC write function, the CRC\_W bit in the [Configuration1 Register](#) must be set to 1. To set the CRC\_W bit to 1 to enable the CRC feature, a valid CRC must be appended to the request frame.

After the CRC feature is enabled, all register write requests are ignored unless they are accompanied by a valid CRC command. A valid CRC is required to both enable and disable the CRC write feature.

### CRC Polynomial

For CRC checksum calculations, the polynomial  $x^8 + x^2 + x + 1$  is always used.

To generate the checksum, the 16-bit data conversion result of the four channels are combined to produce a 64-bit data stream. The eight MSBs of the 64-bit data are inverted and the data is appended by eight bits to create a number ending in eight Logic 0s. The polynomial is aligned such that its MSB is adjacent to the leftmost Logic 1 of the data. An exclusive OR (XOR) function is applied to the data to produce a new, shorter number. The polynomial is again aligned such that its MSB is adjacent to the leftmost Logic 1 of the new result, and the procedure is repeated. This process repeats until the original data is reduced to a value less than the polynomial, which is the 8-bit checksum.

For example, ADAQ4380-4 polynomial is 100000111. Let the original data of four channels be 0xAAAA, 0x5555, 0xAAAA, and 0x5555. The eight MSBs of the data are inverted. The data is then appended to include eight 0s on right. In the final XOR operation, the reduced data is less than the polynomial. Therefore, the remainder is the CRC for the assumed data.

For more details on ADAQ4380-4 CRC operation, see [Table 13](#) and [Figure 78](#).



## REGISTERS

The ADAQ4380-4 has user programmable on-chip registers for configuring the device. [Table 14](#) shows a complete overview of the registers available on the ADAQ4380-4.

The registers are either read/write (R/W) or read only (R). Any read request to a write only register is ignored. Any write to a read only register is ignored. Writes to the NOP registers and the reserved register are ignored. Any read request to the NOP registers or reserved registers are considered a no operation and the data transmitted in the next SPI frame are the conversion results.

**Table 14. Register Description**

|     |                      |        | Bit 15                | Bit 14     | Bit 13    | Bit 12   | Bit 11                 | Bit 10   | Bit 9          | Bit 8      |         |        |     |
|-----|----------------------|--------|-----------------------|------------|-----------|----------|------------------------|----------|----------------|------------|---------|--------|-----|
| Reg | Name                 | Bits   | Bit 7                 | Bit 6      | Bit 5     | Bit 4    | Bit 3                  | Bit 2    | Bit 1          | Bit 0      | Default | R/W    |     |
| 0x1 | Configuration 1      | [15:8] | WR                    | ADDRESSING |           |          | RESERVED               |          | OS_MODE        | OSR, Bit 2 | 0x0000  | R/W    |     |
|     |                      | [7:0]  | OSR, Bits[1:0]        |            | CRC_W     | CRC_R    | ALERT_EN               | RES      | RESERVED       | PMODE      |         |        |     |
| 0x2 | Configuration 2      | [15:8] | WR                    | ADDRESSING |           |          | RESERVED               |          | SDO, Bits[1:0] |            | 0x0000  | R/W    |     |
|     |                      | [7:0]  | RESET, Bits[7:0]      |            |           |          |                        |          |                |            |         |        |     |
| 0x3 | Alert                | [15:8] | WR                    | ADDRESSING |           |          | RESERVED               |          | CRCW_F         | SETUP_F    | 0x0000  | R      |     |
|     |                      | [7:0]  | AI_D_HIGH             | AI_D_LOW   | AI_C_HIGH | AI_C_LOW | AI_B_HIGH              | AI_B_LOW | AI_A_HIGH      | AI_A_LOW   |         |        |     |
| 0x4 | Alert Low Threshold  | [15:8] | WR                    | ADDRESSING |           |          | ALERT_LOW, Bits[11:8]  |          |                |            |         | 0x0800 | R   |
|     |                      | [7:0]  | ALERT_LOW, Bits[7:0]  |            |           |          |                        |          |                |            |         |        |     |
| 0x5 | Alert High Threshold | [15:8] | WR                    | ADDRESSING |           |          | ALERT_HIGH, Bits[11:8] |          |                |            |         | 0x07FF | R/W |
|     |                      | [7:0]  | ALERT_HIGH, Bits[7:0] |            |           |          |                        |          |                |            |         |        |     |

## ADDRESSING REGISTERS

A serial register transfer on the ADAQ4380-4 consists of 16 SCLK cycles. The 4 MSBs written to the device are decoded to determine which register is addressed. The four MSBs consist of the register address (REGADDR), Bits[2:0], and the read/write bit (WR). The register address bits determine which on-chip register is selected. If the addressed register is a valid write register, the read/write bit determines whether the remaining 12 bits of data on the SDI input are loaded into the addressed register. If the WR bit is 1, the bits load into the register addressed by the register select bits. If the WR bit is 0, the command is seen as a read request. The addressed register data is available to be read during the next read operation.

**Table 15. Addressing Register Format**

| MSB |                    |     |     |                  |     |    |    |    |    |    |    |    |    | LSB |    |
|-----|--------------------|-----|-----|------------------|-----|----|----|----|----|----|----|----|----|-----|----|
| D15 | D14                | D13 | D12 | D11              | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1  | D0 |
| WR  | REGADDR, Bits[2:0] |     |     | Data, Bits[11:0] |     |    |    |    |    |    |    |    |    |     |    |

**Table 16. Bit Descriptions for Addressing Registers**

| Bit        | Mnemonic | Description   |
|------------|----------|---|
| D15        | WR       | When a 1 is written to this bit, Bits[11:0] of this register are written to the register specified by REGADDR if it is a valid address. Alternatively, when a 0 is written, the next data sent out on the SDO pin is a read from the designated register if it is a valid address.  |
| D14 to D12 | REGADDR  | When WR = 1, the contents of REGADDR determine the register for selection as outlined in <a href="#">Table 14</a> .<br>When WR = 0 and the REGADDR contains a valid register address, the contents on the requested register are output on the SDOA pin during the next interface access.<br>When WR = 0 and the REGADDR contains 0x0, 0x6, or 0x7, the contents on the SDI line are ignored. The next interface access results in the conversion results being readback. |
| D11 to D0  | Data     | These bits are written into the corresponding register specified by the REGADDR bits when the WR bit is 1 and the REGADDR bits contain a valid address.   |

## REGISTERS

## CONFIGURATION1 REGISTER

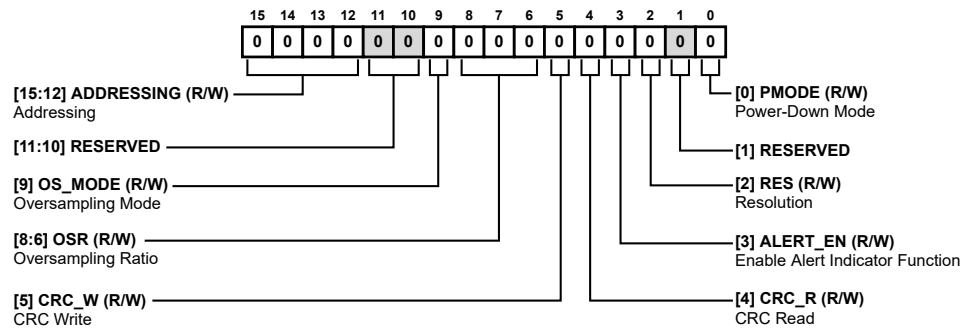


Table 17. Bit Descriptions for Configuration1 Register

| Bits    | Bit Name   | Description   | Reset | Access |
|---------|------------|---|-------|--------|
| [15:12] | ADDRESSING | Addressing. Bits[15:12] define the address of the relevant register. See the <a href="#">Addressing Registers</a> section.  | 0x0   | R/W    |
| [11:10] | RESERVED   | Reserved.   | 0x0   | R      |
| 9       | OS_MODE    | Oversampling Mode. Sets the oversampling mode of the ADC.<br>0: Normal average.<br>1: Rolling average.  | 0x0   | R/W    |
| [8:6]   | OSR        | Oversampling Ratio. Sets the oversampling ratio for all the ADCs in the relevant mode. Normal averaging mode supports oversampling ratios of 2x, 4x, 8x, 16x, and 32x. Rolling average mode supports oversampling ratios of 2x, 4x, and 8x.<br>000: Disabled.<br>001: 2x.<br>010: 4x.<br>011: 8x.<br>100: 16x.<br>101: 32x.<br>110: Disabled.<br>111: Disabled. | 0x0   | R/W    |
| 5       | CRC_W      | CRC Write. Controls the CRC functionality for the SDI interface. When setting this bit from a 0 to a 1, the command must be followed by a valid CRC to set this configuration bit. If a valid CRC is not received, the entire frame is ignored. If the bit is set to 1, it requires a CRC to clear it to 0.<br>0: No CRC function.<br>1: CRC function.          | 0x0   | R/W    |
| 4       | CRC_R      | CRC Read. Controls the CRC functionality for the SDOx interface.<br>0: No CRC function.<br>1: CRC function.   | 0x0   | R/W    |
| 3       | ALERT_EN   | Enable Alert Indicator Function. This register function when SDO bits = 01. Otherwise, the ALERT_EN bit is ignored.<br>0: SDOD.<br>1: ALERT.  | 0x0   | R/W    |
| 2       | RES        | Resolution. Sets the size of the conversion result data. If OSR = 0, these bits are ignored and the resolution is set to default resolution.<br>0: Normal resolution.<br>1: 2-bit higher resolution.  | 0x0   | R/W    |
| 1       | RESERVED   | Reserved.   | 0x0   | R/W    |
| 0       | PMODE      | Power-Down Mode. Sets the power modes.<br>0: Normal Mode.<br>1: Shutdown mode.  | 0x0   | R/W    |



REGISTERS

CONFIGURATION2 REGISTER

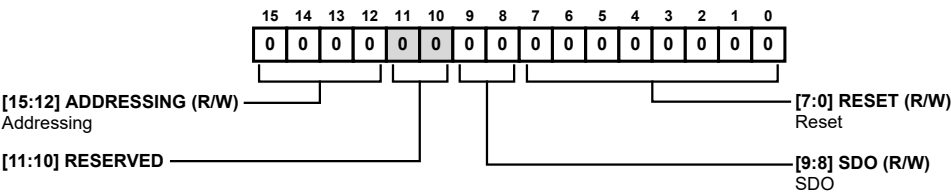


Table 18. Bit Descriptions for Configuration2 Register

| Bits    | Bit Name   | Description   | Reset | Access |
|---------|------------|---|-------|--------|
| [15:12] | ADDRESSING | Addressing. Bits[15:12] define the address of the relevant register. See the <a href="#">Addressing Registers</a> section.  | 0x0   | R/W    |
| [11:10] | RESERVED   | Reserved.   | 0x0   | R      |
| [9:8]   | SDO        | SDO. Conversion Results Serial Data Output.<br>00: 2-wire. Conversion Data are output on both SDOA and SDOB.<br>01: 1-wire. Conversion Data are output on SDOA only.<br>10: 4-wire. Conversion data are output on SDOA, SDOB, SDOC, and SDOD/ $\overline{\text{ALERT}}$ .<br>11: 1-wire. Conversion Data are output on SDOA only.                         | 0x0   | R/W    |
| [7:0]   | RESET      | Reset.<br>0x3C: Performs a soft reset. Refreshes some blocks, Register contents remain unchanged. Clears alert indication register and flushes any oversampling stored variables or active state machine.<br>0xFF: Performs a hard reset. Resets all possible blocks in the device. Registers contents are set to defaults. All other values are ignored. | 0x0   | R/W    |

## REGISTERS

## ALERT INDICATION REGISTER

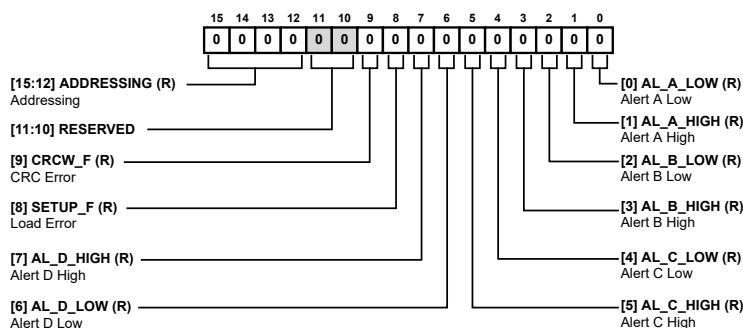


Table 19. Bit Descriptions for Alert Indication Register

| Bits    | Bit Name   | Description   | Reset | Access |
|---------|------------|---|-------|--------|
| [15:12] | ADDRESSING | Addressing. Bits[15:12] define the address of the relevant register. See the <a href="#">Addressing Registers</a> section.  | 0x0   | R      |
| [11:10] | RESERVED   | Reserved.   | 0x0   | R      |
| 9       | CRCW_F     | CRC Error. Indicates that a register write command failed due to a CRC error. This fault bit is sticky and remains set until the register is read.<br>0: No CRC error.<br>1: CRC error.   | 0x0   | R      |
| 8       | SETUP_F    | Load Error. The SETUP_F indicates that the device configuration data did not load correctly on startup. This bit does not clear on an alert indication register read. A hard reset through the <a href="#">Configuration2 Register</a> is required to clear this bit and restart the device setup.<br>0: No setup error.<br>1: Setup error. | 0x0   | R      |
| 7       | AL_D_HIGH  | Alert D High. The alert indication high bit indicates if a conversion result for the respective input channel exceeds the value set in the alert high threshold register. This fault bit is sticky and remains set until the register is read.<br>0: No alert indication.<br>1: Alert indication.   | 0x0   | R      |
| 6       | AL_D_LOW   | Alert D Low. The alert indication low bit indicates if a conversion result for the respective input channel exceeds the value set in the alert low threshold register. This fault bit is sticky and remains set until the register is read.<br>0: No alert indication.<br>1: Alert indication.  | 0x0   | R      |
| 5       | AL_C_HIGH  | Alert C High. The alert indication high bit indicate if a conversion result for the respective input channel exceeds the value set in the alert high threshold register. This fault bit is sticky and remains set until the register is read.<br>0: No alert indication.<br>1: Alert indication.  | 0x0   | R      |
| 4       | AL_C_LOW   | Alert C Low. The alert indication low bit indicates if a conversion result for the respective input channel exceeds the value set in the alert low threshold register. This fault bit is sticky and remains set until the register is read.<br>0: No alert indication.<br>1: Alert indication.  | 0x0   | R      |
| 3       | AL_B_HIGH  | Alert B High. The alert indication high bit indicate if a conversion result for the respective input channel exceeds the value set in the alert high threshold register. This fault bit is sticky and remains set until the register is read.<br>0: No alert indication.<br>1: Alert indication.  | 0x0   | R      |
| 2       | AL_B_LOW   | Alert B Low. The alert indication low bit indicates if a conversion result for the respective input channel exceeds the value set in the alert low threshold register. This fault bit is sticky and remains set until the register is read.<br>0: No alert indication.<br>1: Alert indication.  | 0x0   | R      |

## REGISTERS

Table 19. Bit Descriptions for Alert Indication Register (Continued)

| Bits | Bit Name  | Description  | Reset | Access |
|------|-----------|--|-------|--------|
| 1    | AL_A_HIGH | Alert A High. The alert indication high bit indicate if a conversion result for the respective input channel exceeds the value set in the alert high threshold register. This fault bit is sticky and remains set until the register is read.<br>0: No alert indication.<br>1: Alert indication. | 0x0   | R      |
| 0    | AL_A_LOW  | Alert A Low. The alert indication low bit indicates if a conversion result for the respective input channel exceeds the value set in the alert low threshold register. This fault bit is sticky and remains set until the register is read.<br>0: No alert indication.<br>1: Alert indication.   | 0x0   | R      |

## ALERT LOW THRESHOLD REGISTER

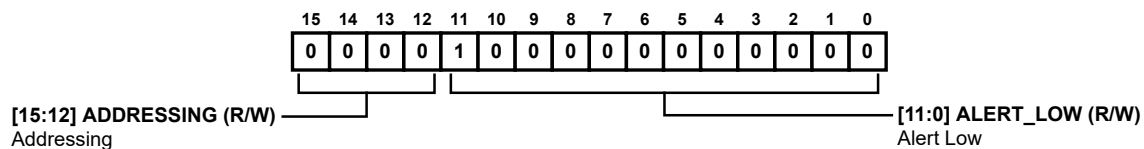


Table 20. Bit Descriptions for Alert Low Threshold Register

| Bits    | Bit Name   | Description  | Reset | Access |
|---------|------------|--|-------|--------|
| [15:12] | ADDRESSING | Addressing. Bits[15:12] define the address of the relevant register. See the <a href="#">Addressing Registers</a> section.   | 0x0   | R/W    |
| [11:0]  | ALERT_LOW  | Alert Low. Bits[11:0] from ALERT_LOW move to the MSBs of the internal alert low register, D[15:4]. The remaining bits, D[3:0] of the internal register are fixed at 0x0. Sets an alert when the converter result is below the value in the alert low threshold register, and the alert is disabled when it is above the value in the alert low threshold register. | 0x800 | R/W    |

## ALERT HIGH THRESHOLD REGISTER

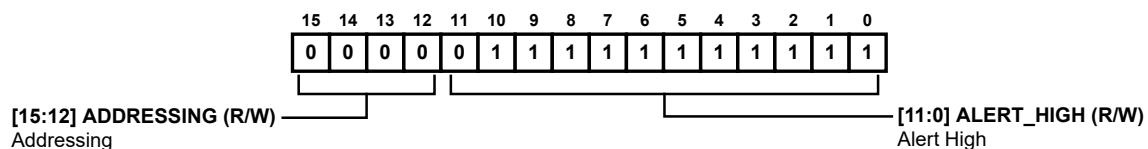


Table 21. Bit Descriptions for Alert High Threshold Register

| Bits    | Bit Name   | Description  | Reset | Access |
|---------|------------|--|-------|--------|
| [15:12] | ADDRESSING | Addressing. Bits[15:12] define the address of the relevant register. See the <a href="#">Addressing Registers</a> section.   | 0x0   | R/W    |
| [11:0]  | ALERT_HIGH | Alert High. Bits D[11:0] from ALERT_HIGH move to the MSBs of the internal alert high register, D[15:4]. The remaining bits, D[3:0] of the internal are fixed at 0xF. Sets an alert when the converter result is above the value in the alert high threshold register, and the alert is disabled when it is below the value in the alert high threshold register. | 0x7FF | R/W    |

## LAYOUT GUIDELINES

To achieve a reliable and optimal performance of the ADAQ4380-4, there are some guidelines for the printed circuit board (PCB).

The PCB layout is critical for preserving signal integrity and achieving the expected performance from the ADAQ4380-4. A multilayer board with an internal, clean ground plane in the first layer beneath the ADAQ4380-4 is recommended. Care must be taken with the placement of individual components and routing of various signals on the PCB. Solder the ground pins of the ADAQ4380-4 directly to the ground plane of the PCB using multiple vias.

The pins of ADAQ4380-4 are placed such that analog and digital signals are easily accessible for optimized routing. The sensitive analog and digital sections must be separated on the PCB while keeping the power supply circuitry away from the analog signal path.

It is highly recommended to route the input and output signals symmetrically. For the best channel-to-channel matching performance, PCB routes of differential input pairs and SDO pins must be matched electrically.

Utilize the ground pins to isolate analog signals from digital signals. Fast switching signals, such as  $\overline{CS}$  or SCLK, and digital outputs, SDOA, SDOB, SDOC, and SDOD, must not run near or cross over analog signal paths to prevent noise coupling to the ADAQ4380-4.

Good quality ceramic bypass capacitors of at least 2.2  $\mu\text{F}$  (0402, X7R) must be placed at the output of the LDO linear regulator generating the ADAQ4380-4 external power supply rails (VS+, VS-, REFIN, VCC, and VLOGIC) to GND to minimize EMI susceptibility and to reduce the effect of glitches on the power supply lines. All the other required bypass capacitors are laid out within the ADAQ4380-4, saving extra board space and cost.

Figure 79 shows the FFT of the ADAQ4380-4 sampling at 4 MSPS with inputs shorted to ground. This performance is verified on the EV-ADAQ4380-4FMCZ evaluation board and no spurs are present in the noise floor. The ADAQ4380-4 is powered using its companion products shown in Figure 65. The recommended board layout for multiple gain options is outlined in the design files on the EVAL-ADAQ4380-4 product page.

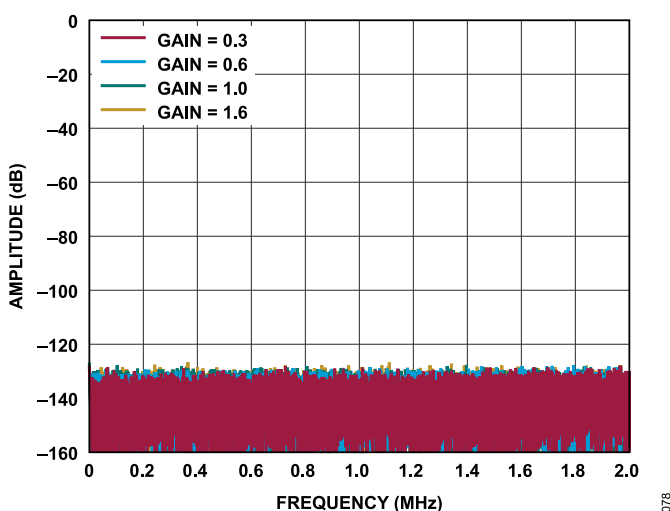


Figure 79. FFT with Shorted Inputs

OUTLINE DIMENSIONS

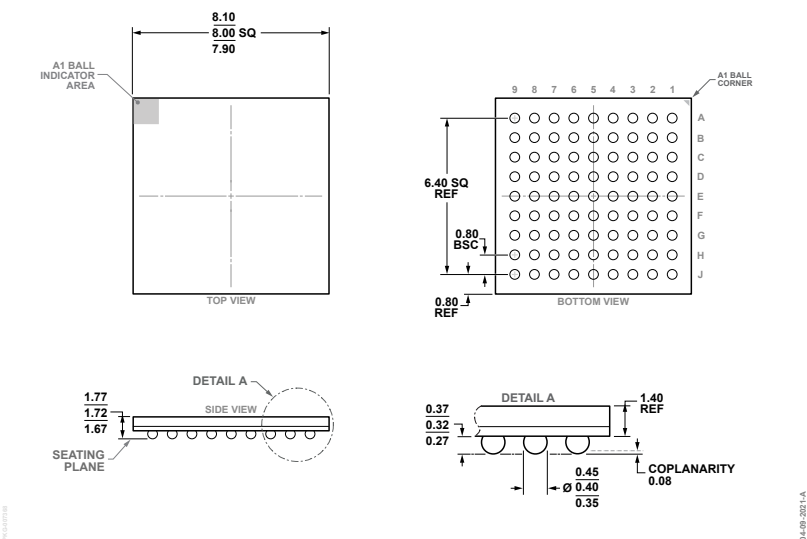


Figure 80. 81-Ball Chip-Scale Package Ball Grid Array [CSP\_BGA]  
(BC-81-7)  
Dimensions Shown in millimeters

Updated: April 12, 2024

ORDERING GUIDE

| Model <sup>1</sup> | Temperature Range | Package Description | Packing Quantity | Package Option |
|--------------------|-------------------|---------------------|------------------|----------------|
| ADAQ4380-4BBCZ     | −40°C to +105°C   | CHIP SCALE BGA      | TRAY, 348        | BC-81-7        |

<sup>1</sup> Z = RoHS-Compliant Part.

EVALUATION BOARDS

| Model <sup>1</sup> | Description      |
|--------------------|------------------|
| EV-ADAQ4380-4FMCZ  | Evaluation Board |

<sup>1</sup> Z = RoHS-Compliant Part.

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[ADAQ4380-4BBCZ](#) [EV-ADAQ4380-4FMCZ](#)